M224XAS

Disk Drives Customer Engineering Manual



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Address comments concerning this manual to:

FUJITSU LIMITED

International Marketing,

6-1 Marunouchi 2-chome, Chiyoda-ku, Tokyo 100, Japan

TEL: 03-216-3211

TLX: J22833

Cable: "FUJITSULIMITED TOKYO"

or

FUJITSU AMERICA INC.

3055 Orchard Drive, San Jose, California 95134-2017, U.S.A. TEL: (408) 946-8777 (FAX TEL: (408) 945-1318)

TLX: 176207

TWX: 910-338-2193

or

FUJITSU EUROPE LIMITED

54 Jermyn Street, London SW1Y 6NQ, ENGLAND

TEL: 01-408-0043

TEX: 263871 FT ERP G

or

r

FUJITSU ELEKTRONIK GmbH

Sonnenstra ße 29 8000 München 2, F.R. GERMANY TEL: 89-52891 - 4 (FAX TEL: (089) 592895)

TLX: 5213994 FEG D

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CHAPTER 1 GENERAL DESCRIPTION

1.1 General Description

1.1.1 General description

The M2241AS/M2242AS/M2243AS disk drives (called M224XAS hereafter) are compact (mini-floppy size), inexpensive, and highly reliable fixed disk drives for random access file in small computers, word processors, and terminals.

The storage capacities (unformatted) of M2241AS, M2242AS and M2243AS are 31.41MB, 54.97MB and 86.39MB respectively.

1.1.2 Features

(1) Compact size

Since the disks are 130 mm (5.12 in) in outer diameter and are driven by a DC motor directly connected to the spindle, the unit is extremely compact in size:

146 mm (5.7 in) (width) x 83 mm (3.3 in) (height) x 203 mm (8.0 in) (depth)

(2) High speed positioning

 $\label{thm:condition} \mbox{High speed head positioning is made possible by utilizing a rotary voice coil motor.}$

(3) High reliability

High reliability is achieved through the following features.

- a. The completely sealed disk enclosure contains a breather filter and a recirculation filter to provide a contamination-free environment.
- b. Whitney-type contact start-stop heads eliminate moving parts associated with head loading and unloading.
- c. All models use LSI circuit logic and a microprocessor.
- d. Head IC's are located on the head arms to amplify the small signal, reducing read errors by increasing the signal to noise ratio.

(4) Preventive maintenance

Preventive maintenance is not necessary.

(5) DC power

The direct-drive DC spindle motor requires no adjustment for line frequencies (50 Hz/60 Hz) or input power voltages (100,115,220 or 240 V).

(6) 5.25 mini floppy disk drive size compatibility

Because its physical size is the same as that of a mini floppy disk drive, this unit can replace a mini floppy disk drive without locker redesign.

(7) Vertical or Horizontal installation

The unit may be installed in its locker either vertically or horizontally.

(8) Low power consumption

The power consumption is 30W. This low power consumption enables the unit to be used in a wide environmental temperature range (5 to 45° C) without a cooling fan.

(9) Low noise

The unit's low noise output, approx. 45 dB (A-scale weighting) even during seeking, makes it ideal for office use.

(10) Low vibration

The unit has four rubber vibration isolators, which minimize the transfer of motion.

(11) LSIs and microprocessor

LSIs and microprocessor are used on the main printed circuit board to achieve high reliability.

1.2 Specifications

1.2.1 Performance

| | Model | M2241AS | W224245 | M2243AS | |
|---|------------|---|---------------------------|----------------|--|
| Specification | | M2241A5 | M2242AS | M2243AS | |
| Total storage capacity Unformatted Formatted(*) | (MB) | 31.41 24.70 | 54.97 43.23 | 86.39 67.94 | |
| Storage capacity/track Unformatted Formatted(*) | (B) (B) | | 10416 8192 | | |
| Number of disks | | 3 | 4 | 6 | |
| Number of heads (R/W) | | 4 | 7 | 11 | |
| Number of cylinders | | 754 | 754 | 754 | |
| Number of tracks/cylinder | | 4 | 7 | 11 | |
| Number of sectors | | | 32 | | |
| Recording density | (BPI) | 10200 | | | |
| Track density | (TPI) | 760 | | | |
| Transfer rate | (KB/S) | 625 | | | |
| Rotational speed | (rpm) | 3600 ± 1% | | | |
| Average latency time | (ms) | 8.3 | | | |
| Recording method | | MFM | | | |
| Positioning time Min | (ms) | | 8 | | |
| REFER TO NOTE Ave | (ms) | 33 | | | |
| Max | (ms) | | 60 | | |
| Input voltage (Typical) | | +12V±5%, 1. | +12V±5%, 1.8A (max. 4.3A) | | |
| | - | +5V±5%, 1.6A | | | |
| Maximum ripple | mV | < 100 (P-P) | | | |
| External size Width × height × depth | (mm) | | < 83 × 203 | sion) | |
| Disk size | (mm) | (w/o panel dimension) Outer diameter 130, Inner diameter 40 | | | |
| Weight | (kg) | 3.0 | | | |

^{(*) 512} bytes/sector for 16 sectors. 256 bytes/sector for 32 sectors.

NOTE:

The M224XAS drives were designed to begin seeking after all step pulses were received (labeled Full-buffered seek mode). When the step pulse period was relatively long (e.g. >30 us), the time to Seek Complete exceeded the drive's specified access time. For example, with a period of 40 us, a maximum seek required:

For this reason, the circuit was redesigned to allow the drive to begin seeking without waiting for the last step pulse (labeled semi-buffered seek mode).

APPLICATION CONDITION:

Step pulse period T_w ≥ 20 us

2. Key 8 of SWI should be turned "ON"

-step pulse

NOTES

- a. If Key 8 is set "OFF", the drive is programmed for Full-buffered Mode.
- b. If Key 8 is set to "ON", and the step period is shorter than 20 us, the normal seek operation cannot be performed.
- c. When the drive receives more than 753 step pulses an RTZ or recalibration is performed. In the semi-buffered Mode, however, the following procedure is recommended for RTZ.
 - 1. Set Direction false.
 - 2. Send one step pulse.
 - 3. Wait for seek Complete to become active.
 - 4. Continue 2 & 3 until Track 0 become active.

EFFECT OF SEMI-BUFFERED SEEK MODE:

The relationship between step pulse period and access time in Full buffered and Semi-buffered Seek Modes are shown in Figure 1.

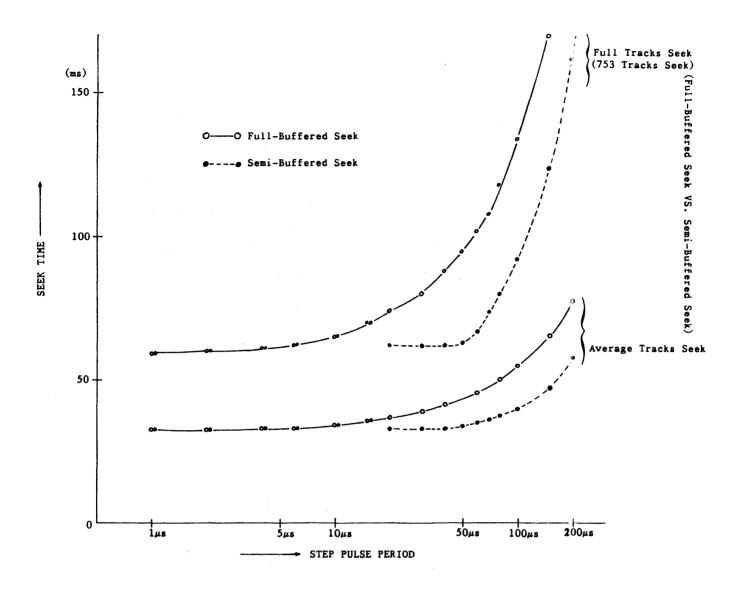
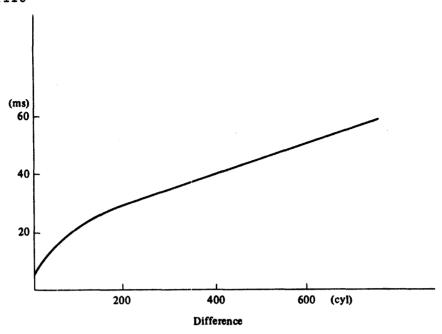


Fig. 1 ACCESS TIME CURVE

1.2.2 Seek Profile



1.2.3 Start and stop time

Start time (time from power turn on, until the unit is ready) is 20 seconds or less and stop time (time to completely stop when power is turned off) is 15 seconds or less using dynamic braking.

1.2.4 Environmental conditions

| Temperature | Operating Non-operating Gradient | 5°C to 45°C -40°C to 60°C 15°C/h or less |
|--------------------------------|---|--|
| Relative humidity | Operating Non-operating | 20% to 80% RH 5% to 95% RH (Moisture must not condense.) |
| Vibration | Operating Non-operating (power-off state after installation) | Less than 0.2G (3 to 100 Hz) 2 min x 30 cycles (except resonance point) (sinusoidal waveform) Less than 0.4G (3 to 100 Hz) 2 min x 30 cycles (sinusoidal waveform) |
| Shock | Operating Non-operating | Less than 2G (maximum 10ms) Less than 20G (maximum 10ms) |
| Altitude above sea level | Operating Non-operating time | 3,000m or below 12,000m or below |

1.2.5 Power supply requirements

(1) Input voltage and permissible input voltage variation

| | Input voltage |
|-------|---------------|
| +12 V | +12 V±5% |
| +5 V | +5 V±5% |

The above values are voltages at the power supply input connector of the unit.

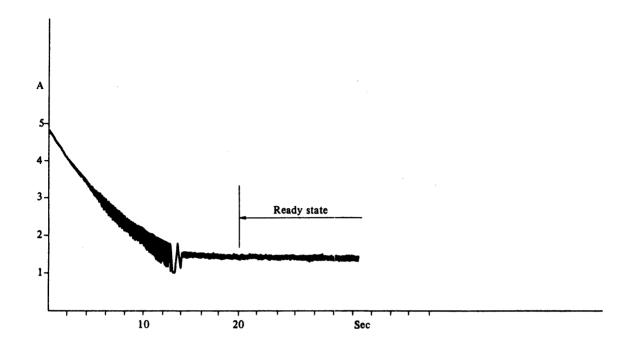
(2) Power supply requirements (minimum)

| Voltage | Power-On | Seeking | Idle |
|---------|----------|---------|------|
| +5 | 2.2A | 2.0A | 1.6A |
| +12 | 4.3A | 3.1A | 1.8A |

Figure 1.1 shows current waveforms of +12V power during the following conditions:

- Spindle motor begins to rotate
- During seek operation

(i) Spindle motor begins rotation



(ii) Alternate Seeking and reading 0 to 227 cylinders

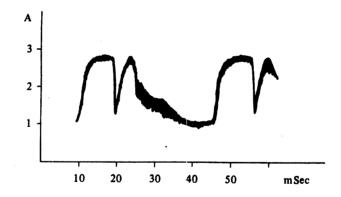


Figure 1.1 Current waveform of +12V power

1.2.6 Reliability

(1) Mean Time Between Failures (MTBF)
M224XAS has a design MTBF of more than 20,000 hours. (After an initial 3-month period.)

Note: The MTBF is defined as follows:

MTBF = Operating Time (hours)/The number of Equipment Failures from All Field Sites.

Operating time is total power on time.

Failure of the equipment means failure that requires either repairs, adjustments, or replacement. Mishandling by the operator, failures due to bad environmental conditions, power trouble, controller trouble, cable failures, or other failures not caused by the equipment are not included.

- (2) Mean Time To Repair (MTTR)
 MTTR is the average time taken by a well-trained service technician to diagnose and repair a unit malfunction. The M224XAS is designed for a MTTR of 30 minutes or less.
- (3) Service life
 Overhaul of the M224XAS is not required for the first five years.
- (4) Power loss
 Integrity of the data on the disk is guaranteed against all forms of abnormal DC power failure except a power failure during writing.

1.2.7 Error rate

Errors detected upon initialization and replaced by an alternate record are not included in the error rate.

- (1) Recoverable error rate A recoverable error is one which can be read correctly within one retry and should not exceed 10 errors per 10^{11} bits read.
- (2) Non-recoverable error rate Errors that cannot be recovered within 16 retries are included in the MTBF.
- (3) Positioning error rate

 The rate of positioning errors recoverable by one retry is 10 errors or less per 10⁷ seeks.
- (4) Media error
 - (a) All tracks of cylinder 0 are defect free.

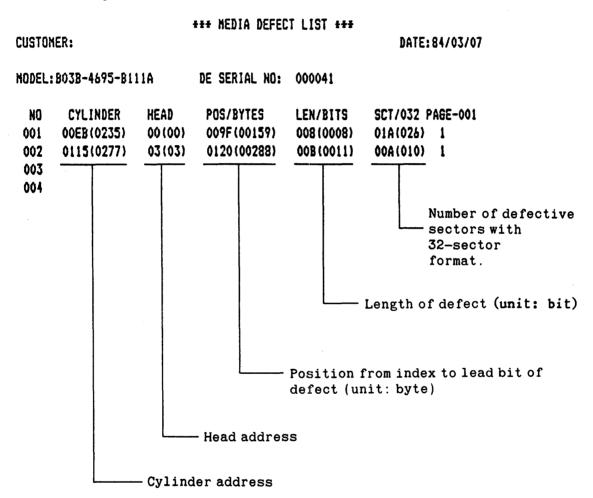
(b) The maximum number of defects in the M224XAS are as follows:

M2241AS 32 or less M2242AS 55 or less M2243AS 86 or less

Note: The number of defects per one surface is 24 or less Defect length > 64 bytes

(3) Media defect list

Media defects for units shipped from the factory are listed on the MEDIA DEFECT LIST and this list is attached to each drive. The following figure shows an example of the MEDIA DEFECT LIST. Locations are in hexadecimal; numbers in parentheses are decimal equivalents.



1.3 Structure

1.3.1 Structure of device

Figure 1.2 shows the structure of the device.

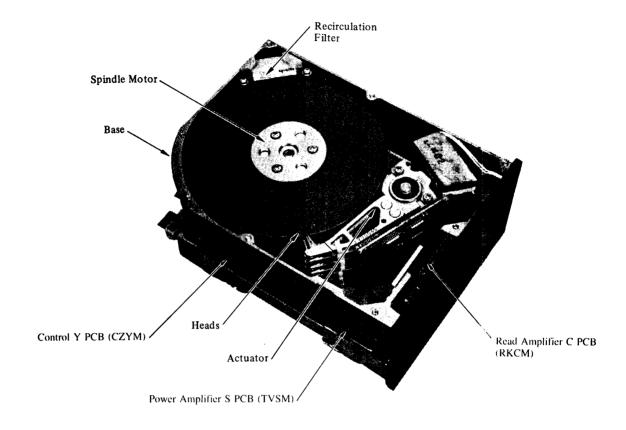


Figure 1.2 Structure

2.1 General Description

This chapter describes unpacking, installation and cabling of the M224XAS.

2.2 Unpacking

The M224XAS is shipped in a carton with form fitting cushions. An exterior view of the carton is shown in Figure 2.1.

- (1) Place the carton on a flat surface. Ensure that the top of the box, indicated by a ''This Side Up'' sign, is oriented correctly.
- (2) Open the carton and take out the top cushion.
- (3) Pull the M224XAS out of the carton by grasping its base. Move the drive slowly and carefully, to prevent unnecessary shock.

CAUTION

When transporting, installing or servicing, avoid shocks to the drive to protect the heads and media from damage.

When transporting the drive, use the specified carton.

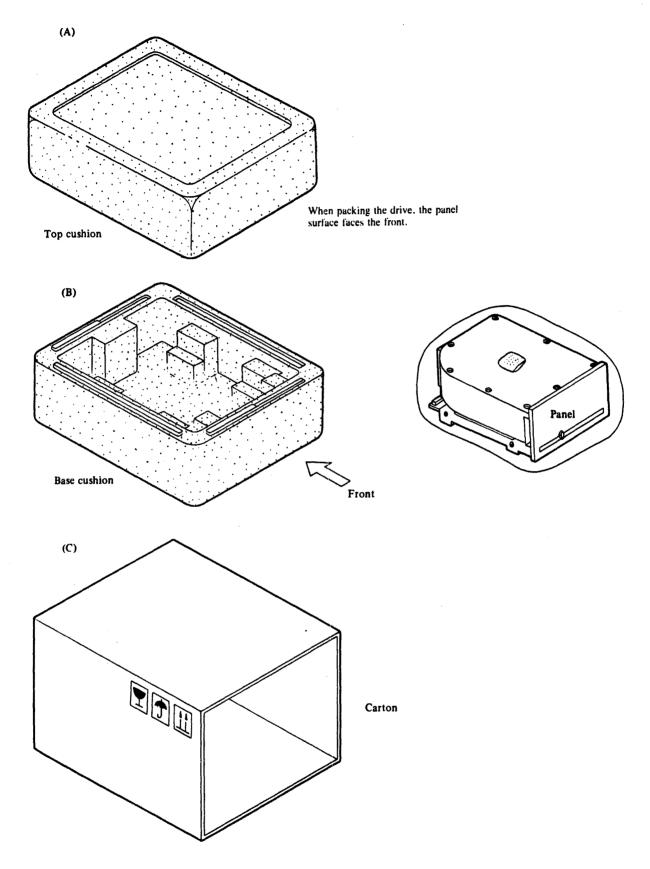


Figure 2.1 Exterior view of cartion

2.3 Visual Inspection

After unpacking, check the following:

- (1) There should be no cracks, rust or other damage.
- (2) All parts should be firmly fixed, there should be no loose screw, etc.
- (3) The MEDIA DEFECT LIST should be attached.

2.4 Cable Connection

A total of four drives can be connected to one controller.

Cable connection is as follows.

2.4.1 Unit connectors

The A/B cable edge connectors, powers, and signal ground (SG) connectors are arrayed as shown in Figure 2.2.

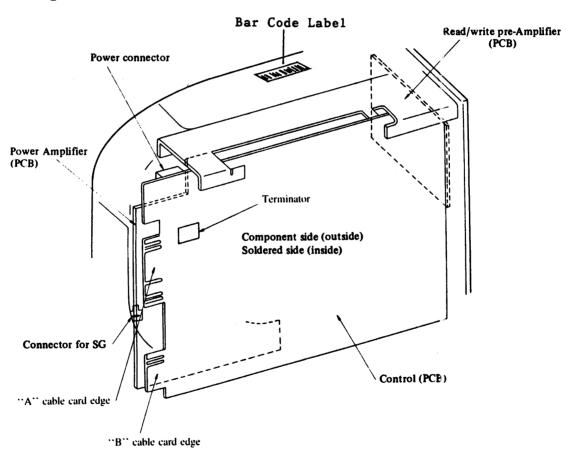


Figure 2.2 Unit Connectors

2.4.2 Connection

Connection of units to their controller is shown in Figure 2.3. To connect more than one unit, the A cable (control signals) must be connected in series and the B cables (R/W signals) in parallel. The termination of control signals must be performed only at the last drive. The termination resistor pack must be removed from all but the last drive. See Figure 2.2 for terminator location.

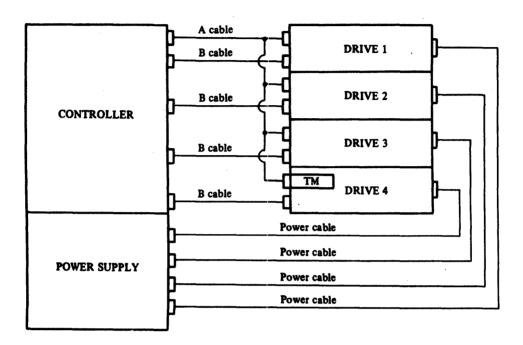


Figure 2.3 Multiple Units Connection

2.4.3 Cable connector specifications

The recommended cable connector specifications are listed in Table 2.1.

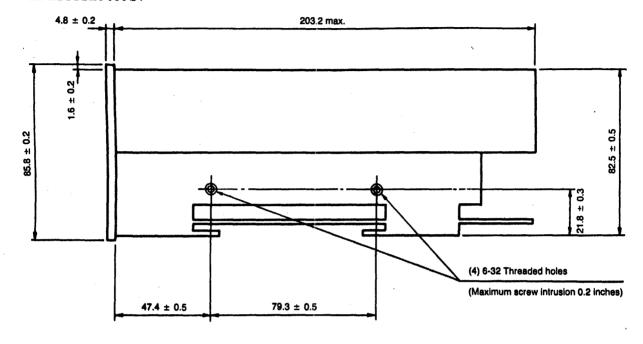
Table 2.1 Cable Connector Specifications

| Connector | Name | Spec. No. | Manufacturer |
|---------------|--|--|-------------------------|
| Cable A | Cable connector | FCN-767J034-AU/1 or 88373-3 or 3463-0001 | FUJITSU AMP 3M |
| (34P) | Unit card edge | _ | _ |
| | Cable | 455-248-34 or 171-34 | SPECTRA-STRIP ANSLEY |
| Cable B (20P) | Cable connector | FCN-767J020-AU/1 or 88373-6 or 3461-0001 | FUJITSU AMP 3M |
| | Unit card edge | _ | - . |
| | Cable | 455-248-20 or 171-20 | SPECTRA-STRIP ANSLEY |
| | Cable connector | 1-480424-0 | AMP |
| | Unit connector | 1-350211-1 | AMP |
| Power cable | Contact | 170121-4 | AMP |
| | Cable | AWG 18 (+5V, RTN) AWG 18 (+12V, RTN) | _ |
| SG cable | Fasten receptacle for cable side | 62187-1 | AMP , |
| | Fasten tab for the device | 61761-2 | AMP |
| | Cable | AWG 20 | |

2.5 Installation

2.5.1 Device outer dimensions

Figure 2.4 shows the device outer measurements and mounting dimensions. Dimensions are in millimeters.



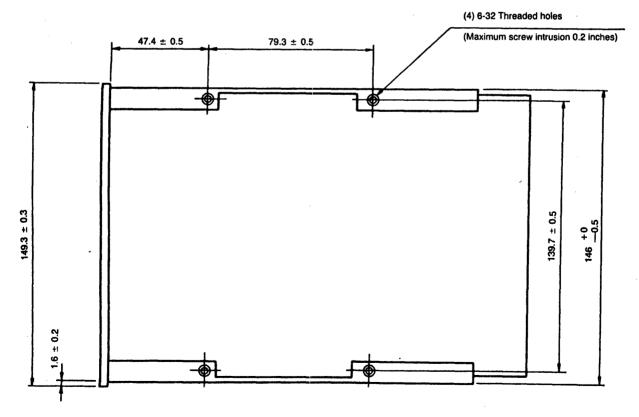
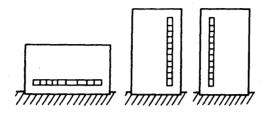


Figure 2.4 Device Outer Measurements

2.5.2 Notes on installation

(1) The unit may be installed horizontally or vertically as follows.

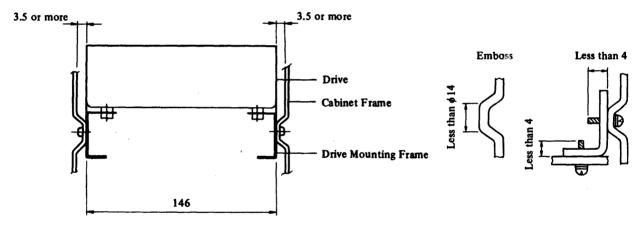
FRONT VIEW



(2) Frame structure

The disk enclosure (signal ground) is isolated from the drive mounting frame (frame ground).

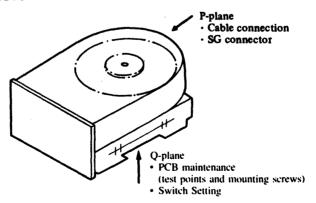
When mounting the drive in a cabinet frame, the frame should clear the drive by at least 3.5 mm to prevent the drive from touching the cabinet frame.



(3) Ambient temperature

The operating temperature range of the drive is specified at a distance of $3\ \mathrm{cm}$ from the unit.

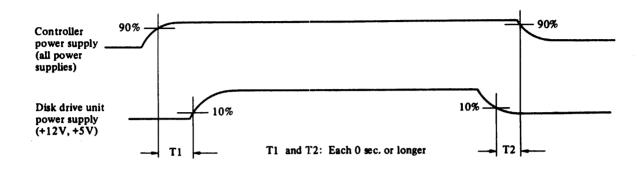
(4) Service area



2.6 Power On/Off Sequence

If the Write Gate signal from the controller is off before applying or removing power, the voltages (+12 V, +5 V) to the drive need not be sequenced. That is, recorded data will not be destroyed nor will mechanical or electric problems occur. To maintain the Write Gate signal in the off state at the time of unit power-on or -off, the basic sequence between the power supply of the controller and drive unit is as follows.

(1) Basic sequence



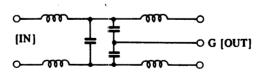
Note) The power supplies of the disk drive unit (+12 V, +5 V) need not be sequenced when above timing is observed.

(2) If the controller and the drive share a common supply and the Write Gate interface signal is determined only by +5 V, power sequencing is unnecessary. This is because the +5 V level is monitored within the drive.

2.7 Others

(1) To eliminate AC line noise, a noise filter of the specifications given below should be incorporated in the AC input terminal of the disk drive power supply.

Attenuation characteristic; 40 dB or greater at 10 MHz Circuit configuration; T type shown below is recommended.



2.8 Switch setting procedure

The functions and assignment procedures of the switch are described below. The mounting location on the main PCB is illustrated in Figure 2.5.

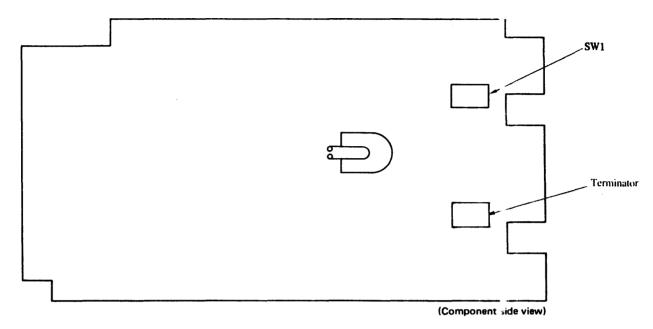


Figure 2.5 Switch Mounting Location

- (1) Control of DRIVE SELECTED Signal Key 5 in SWl
 - "ON" side ... A drive is in a selected state regardless of DRIVE SELECT $1 \sim 4$, which means DRIVE SELECTED signal is always true and all Input/Output signals are validated without selecting the drive.
 - "OFF" side .. DRIVE SELECTED signal is true and all Input/Output signals are validated only when a drive is selected with DRIVE SELECT $1\, 2$.
- (2) DRIVE SELECTION Key 1 ∿ Key 4 in SW1
 Key 1 ∿ 4 in SW1 are used to select one of up to a maximum of four drives.
 The relevant one of four keys is to be turned ''ON'' while the others should be turned ''OFF.'' The selection procedures are shown in Table 2.2.

Table 2.2 Device Selection

| DRIVE NUMBER | Key Number in SWl | | | | |
|-----------------|-------------------|---|---|---|--|
| | 1 | 2 | 3 | 4 | |
| 1 | 0 | × | × | × | |
| 2 | × | 0 | × | × | |
| 3 | × | × | 0 | × | |
| 4 | × | × | × | 0 | |

o: "ON" ×: "OFF" (3) MOTOR-ON Key 6 and 7

When multiple drives are connected to a system, the +12V power supply may be overloaded. To prevent such a situation, a circuit was added which allows for power-up sequencing by the system.

The controller may send an enabling signal, Motor-On, over the 'B' cable (Pin 5).

The drive monitors Motor-On signal for one second after power is applied and waits for this signal to become true (low level at interface connector).

Motor-On signal can not be used to stop the spindle motor.

The function is controlled by Keys 6 and 7 of Switch 1.

Settings are as follows:

| | Key 6 | Key 7 |
|-------------------|-------|-------|
| Motor-On Enabled | OFF | ON |
| Motor-On Disabled | ON | OFF |

When the Motor-On function is disabled, the spindle motor will begin rotating one second after power is applied.

This signal is not gated by Drive Select signal.

If Motor-On is enabled and Motor-On signal is not received on the interface, the drive will not start.

(4) FULL BUFFERED/SEMI-BUFFERED SEEK MODES Key 8

The M224XAS drives were designed to begin seeking after all step pulses were received (labeled Full-buffered seek mode). When the step pulse period was relatively long (e.g. >30 us), the time to Seek Complete exceeded the drive's specified access time.

For this reason, the circuit was redesigned to allow the drive to begin seeking without waiting for the last step pulse (labeled semi-buffered seek mode).

APPLICATION CONDITION:

- 1. Step pulse period $T_w \ge 20$ us
- 2. Key 8 of SWI should be turned "ON"

-step pulse T_w

NOTES

- a. If Key 8 is set "OFF", the drive is programmed for Full-buffered Mode.
- b. If key 8 is set "ON", and the step period is shorter than 20 us, the normal seek operation cannot be performed.
- c. The drive will accept step pulses with a period between $0.3~\mu s$ and $200~\mu s$. When the period is between $0.3~\mu s$ and $19~\mu s$, the drive must be programmed to operate in the buffered mode. When the period is between $20~\mu s$ and $200~\mu s$, the drive must be programmed to operate in the semi-buffered mode.

3.1 General Description

This chapter consists of the following sections:

- (1) Mechanical parts
- (2) Servo surface information and data surface track format
- (3) Interface and electrical control section

3.2 Unit Structure

The M224XAS consists of disks, heads, spindle motor, actuator, cover, recirculation filter, base, Read/Write pre-amplifier (PCB), power amplifier (PCB), and control (PCB). Refer to Figure 1.2.

(1) Disks

Disks are 130 mm in outer diameter and 40 mm in inner diameter and are coated with a special lubricating material (Winchester-type). M2241AS, M2242AS and M2243AS have 3, 4 and 6 disks respectively. Durability is designed for over 10,000 contact starts and stops.

(2) Heads

The Whitney-type heads are in contact with the disks when the disks are not moving, but automatically float when the rotation reaches nominal speed.

The number of heads (R/W) is four in the M2241AS, seven in the M2242AS, and eleven in the M2243AS. Each model has a single servo head to read a servo pattern pre-written at the factory on the bottom disk's lower surface.

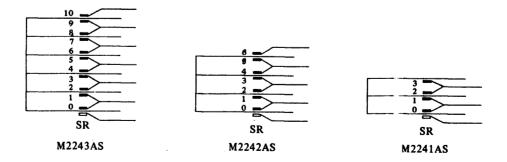


Figure 3.1 Disk/Head Configuration

(3) Spindle motor

The disks are turned by a direct-drive DC motor. The motor attains a very precise rotational speed of 3600 rpm, $\pm 1\%$. This precision is achieved through a feedback circuit which includes Hall-effect elements mounted within the motor assembly.

(4) Actuator

This assembly consists of a rotary type actuator, moving coil, permanent magnet, and head arms with data heads and servo head.

The actuator which is controlled by a servo feed-back current, gives increased reliability and a very short average positioning time of 33 ms.

(5) Air circulation

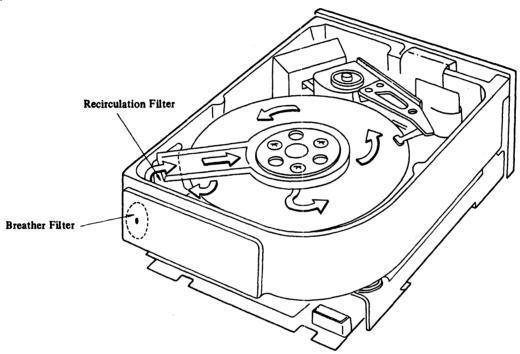


Figure 3.2 Air Circulation

As shown in Figure 3.2, the heads, disks and actuator are sealed inside a cover to shut out any contamination. This head disk assembly has a closed-loop air recirculation system using the blower effect of the rotating disks to continuously cycle air through the recirculation filter. This filter traps any dust generated inside the enclosure. To prevent negative pressure in the vicinity of the spindle when the disks begin rotating, a breather filter is attached. This breather filter also equalizes the internal air pressure with the atmospheric pressure due to surrounding temperature changes.

3.3 Recording Media

3.3.1 Servo track format

(1) Servo track configuration
The servo area is used to store the special data patterns which generate
Track Positioning, Index, Guard Band, and Clock signals. This data is recorded
on the disk before the unit is shipped from the factory
The servo area consists of a combination of ODD1, ODD2, EVEN1 and
EVEN2 tracks. The physical placement of servo tracks is shown in
Figure 3.3. The servo tracks are divided into the following five
parts:

- a. Dead Space (DS)

 DS consists of five DC-erased tracks and is recognized as Head
 Unloaded through the servo circuit.
- b. Inner Guard Band 2 (IGB2)
 Inner Guard Band 2 is used for speed control during Return To Zero (RTZ)
 or Initial seek sequence. IGB2 consists of six EVEN1-EVEN2 tracks, six
 ODD1-EVEN2 tracks, six ODD1-ODD2 tracks and five EVEN1-ODD2 tracks (23
 tracks total).
- c. Inner Guard Band 1 (IGB1)
 Inner Guard Band 1 is located between IGB2 and Cylinder 0, and is
 used for speed control during RTZ or Initial Seek sequence. IGB1
 consists of four EVEN1-EVEN2 tracks, four ODD1-EVEN2 tracks, four
 ODD1-ODD2 tracks and four EVEN1-ODD2 tracks (16 tracks total).
- d. Servo Band
 Servo Band is used for tracking to determine the center of each
 cylinder. The Servo Band consists of 189 EVEN1-EVEN2 tracks, 189
 ODD1-EVEN2 tracks, 189 ODD1-ODD2 tracks, and 190 EVEN1-ODD2
 tracks (757 track total). However, 1.5 inner tracks of
 Cylinder 0 and 1.5 outer tracks of Cylinder 753 are not
 utilized for corresponding data tracks.
- e. Outer Guard Band (OGB)
 The Outer guard Band is used to recognize that the head has passed through the servo zone in an outward direction. OGB consists of four EVEN1-EVEN2 tracks, four ODD1-EVEN2 tracks, three ODD1-ODD2 tracks and three EVEN1-ODD2 track minimum (14 tracks minimum total).

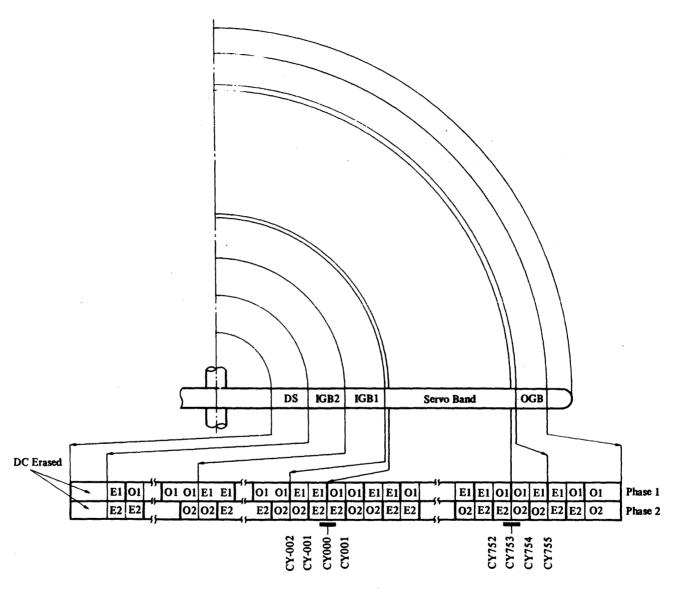


Figure 3.3 Servo Track Configuration

3.3.2 Servo pattern

The servo signal is a unique ''Dual-phase composite servo signal'' which creates a high-performance positioning system. It is used to achieve angular positioning (location with reference to the circumference of the disk) and radial positioning (location with reference to the radius of the disk).

Angular positioning is determined by a series of sync bits which are written on each track. Through a combination of Index Bit and Normal Fit, the ''sync pattern'' is developed. A series of unique sync patterns is written at the factory and used in the indentification of specific disk regions. Refer to Figure 3.4 and Figure 3.5

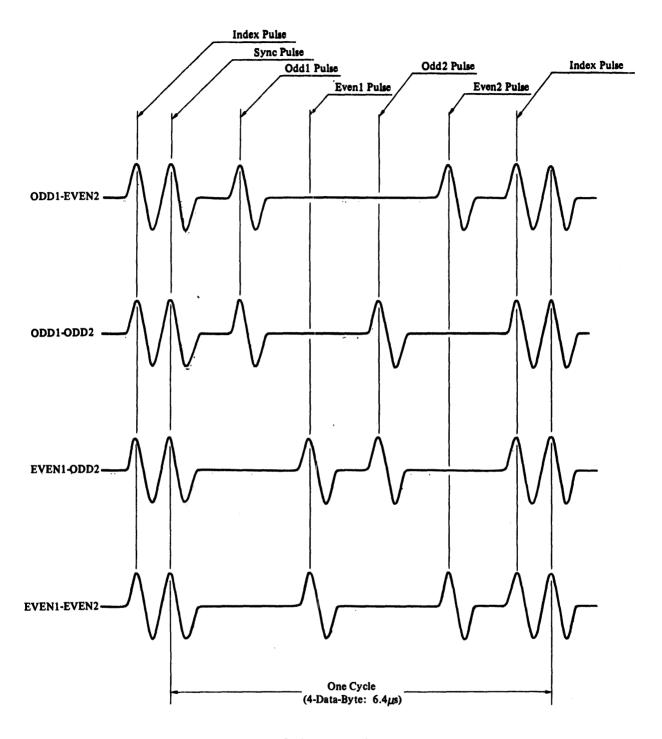


Figure 3.4 Normal Bit Pattern

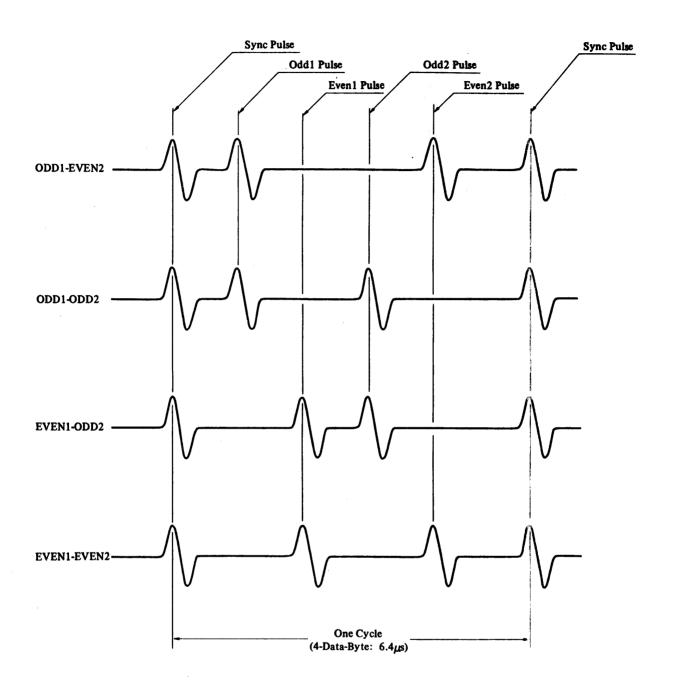


Figure 3.5 Index Bit Pattern

Radial positioning information is provided by writing ODD1-EVEN2, ODD1 -ODD2, EVEN1-ODD2, and EVEN1-EVEN2 patterns, in that order, on the servo surface.

During head movement, the servo circuit detects the amplitude changes between ODD1 and EVEN1 peaks (phase1), and between ODD2 and EVEN2 peaks (phase2), and then converts them into two position signals (phase 1: Normal, phase 2: Quadruture) through position sensing.

After head movement, the servo head, which has double the core width of the data head, settles on the border of two types of servo patterns controlled by the two least-significant bits of the target cylinder address. The servo circuit then makes the ODD1 (or ODD2) peak equal to the EVEN 1 (or EVEN2) peak by positioning the servo head on the center of the servo track. Refer to Figure 3.6.

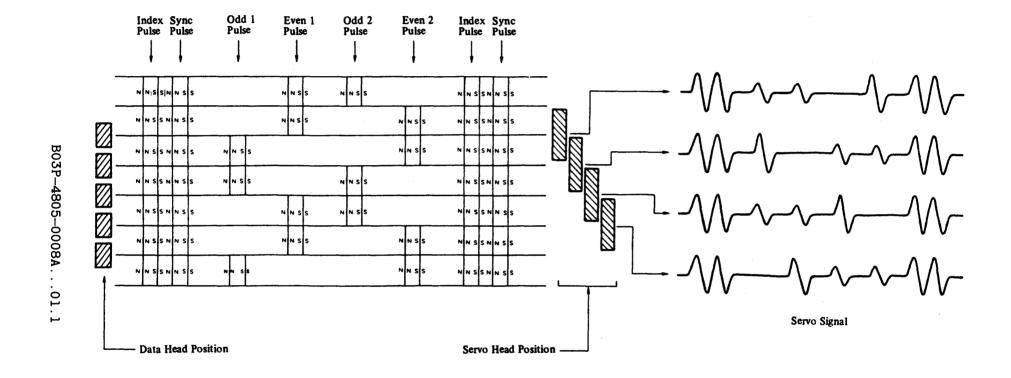


Figure 3.6 Dual-Phase Composite Servo Signal

3.3.3 Index guard band patterns

Index (INX), Sector (SCT), IGB2, IGB1, and OGB patterns are detected by decoding the combination of Index bits and Normal bits. Each of the patterns are shown in Table 3.1.

Table 3.1 Index, IGB2, IGB1, and OGB Patterns

| Signal | Pattern | Pattern interval |
|--------|---------|------------------|
| Index | 01011 | 10,416 B |
| SCT | 01101 | 325 В |
| IGB2 | 01110 | 260 В |
| IGB1 | 01010 | 260 B |
| OGB | 10011 | 260 В |

Note: 0-Normal bit

3.3.4 Data surface format

The data surface consists of 754 cylinders for data recording. Cylinder 0 inner most and Cylinder 754 is the outer most data cylinder.

(1) Track format

a. General

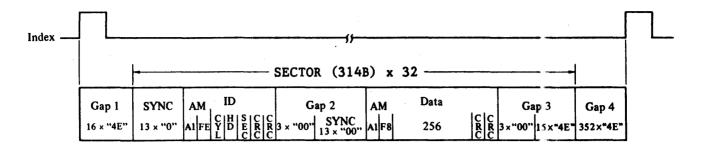
The soft sector format, which is the same as that for floppy disk drives, is used as the track format for these drives. Each sector consists of an identify (ID) field for checking that the correct sector is read and a data field for actually recording data.

The sector format is decided by the controller. This section explains the format written at the factory.

Sector interleave format (factor = 4) is set at the factory. A track has 32 sectors.

| Index | | | | | | | | | |
|-------------------------|----|----|----------|---|----|----|---|---|----|
| Logical Sector number . | 23 | 31 | 0 | 8 | 16 | 24 | 1 | 9 | 17 |
| Physical Sector number | | | <u> </u> | | | | 2 | | |

b. Track format written at the factory



Notes:

- 1. The track capacity varies according to the motor rotation fluctuation. The nominal track capacity is 10,416 bytes.
- 2. The nominal capacity of Gap 4 is 352 bytes.
- 3. 16 x ''4E''

 Indicates the hexadecimal bit pattern.

 Indicates the number of bytes.

(2) Format configuration

a. Gap 1

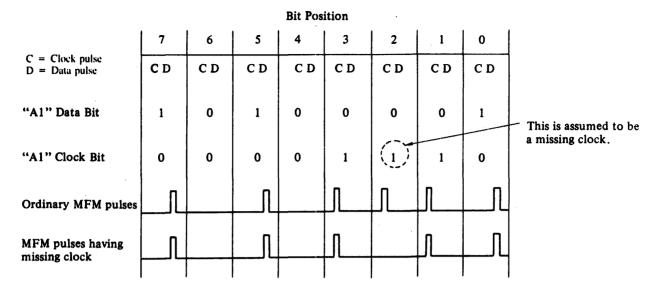
Absorbs the index burst fluctuation. Sixteen bytes of ''4E'' patterns are written in this gap.

b. SYNC

VFO synchronization area for reading the ID and data fields. Thirteen bytes of ''00'' patterns are written in this field.

c. Address mark (AM)

Identifies the heading part of the ID and data fields.
''Al'' patterns are written in the following missing clock format to detect the AM.



The data pattern of byte 2 succeeding the A1 pattern of AM as follows:

ID field:

FE at cylinders 0-255

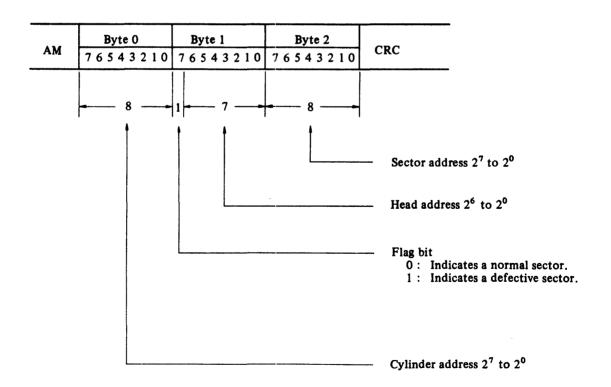
FF at cylinders 256-511

FC at cylinders 512-753 F8

Data field:

d. Identify (ID) field

The ID field consists of seven bytes, including AM and CRC. The three bytes other than AM and CRC have the following bit configurations:



e. Cyclic Redundancy Check (CRC) field

Error detection code including AM (Al pattern). The polynomial is as follows:

$$X^{16} + X^{12} + X^5 + 1$$

Note: The CRC initial value is FFFF.

f. Gap 2

Area for reading/writing the data field. The data pattern for synchronizing the variable frequency oscillator (VFO) is "00".

g. Data field

This is the user area.

h. Gap 3

Consists of 3-byte "00" patterns for writing the data field and 15-byte "4E" patterns for absorbing motor rotation fluctuation.

i. Gap 4

Area for absorbing motor rotation fluctuation used when formatting all sectors in a track at the same time. This area consists of 352-bytes of ''4E'' patterns (nominal rotation number).

(3) Write precompensation

Whenever two bits are written in close proximity to each other, a phenomenon called pulse superposition occurs, which tends to cause the two bits to move away from each other. This factor contributes to bit shift. The effect of bit shift can be reduced by a technique called precompensation, which, by detecting which bits will occur early and which bits will occur late, can effectively minimize the shift by writing these bits in the opposite direction of the expected shift.

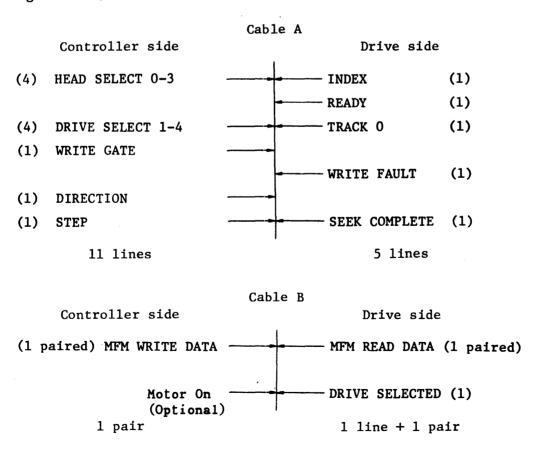
The optimum amount of pre-compensation is 12 nanoseconds for both early and late written bits. No precompensation is, however, required. The following table shows various bit patterns for precompensation.

| WRITE POSITION | DIRECTION OF SHIFT |
|--|--------------------|
| 0000 | = On Time Clock |
| 0001 | = Early Clock |
| 0 0 1 0 | = On Time Data |
| 0 0 1 1 | = Late Data |
| 0 1 0 0 | |
| 0 1 0 1 | |
| 0 1 1 0 | = Early Data |
| 0 1 1 1 | = On Time Data |
| 1 0 0 0 | = Late Clock |
| 1001 | = On Time Clock |
| 1010 | - On Time Data |
| 1011 | = Late Data |
| 1 1 0 0 | |
| 1 1 0 1 | |
| 1110 | = Early Data |
| Early $\frac{1}{1}$ $\frac{1}{1}$ Late | ■ On Time Data |

3.4 Interface

This section describes the physical and logical conditions of the signals transferred through the interface between the disk drive and the disk control unit. The timing is specified at the driver/receivers of the drive.

3.4.1 Signal Lines



3.4.2 Input signals

- (1) Head Select 0 to 3
 These signal lines are used to select one of up to eleven data heads in the disk drive.
- Orive Select 1 to 4
 These signal lines are used to select from one of up to four drive units in a multi-drive configuration and validate the input/output signals of the selected disk drive.
- (3) Direction
 This signal line is used to determine the seek direction of the data heads when the step pulses are sent to the disk drive. When this signal is true, seek is performed away from Track 0; when false, seek is performed toward Track 0.
- (4) Step
 This signal moves the data heads one track per pulse in the direction indicated by the Direction signal. There are two stepping modes as follows:
 - (i) Slave step mode
 When the step pulse rate is between 5 kHz and 3 MHz, the seek
 operation does not commence until all the step pulses have arrived
 and responds with the Seek Complete signal after completing all
 seeks.
 - Note) Step rates 5 kHz or less are prohibited.
 - (ii) Return to zero mode
 When 754 or more step pulses are issued in slave step mode, the
 data heads will move to Cylinder 0.
 If the controller does not use this Mode, the recalibrate function
 should be performed using the following procedure.
 - (1) Set the Direction to false.
 - 2 Send one step pulse.
 - (3) Wait until the Seek Complete signal is TRUE.
 - (4) Continue the procedure until the Track O signal is TRUE.

Note: An illegal step pulse which would position the heads outside of the recording zone or an internal seek fault will cause the drive to position the heads at Cylinder O automatically, using its internal recalibration procedure. The drive will then activate Track O and Seek Complete signals.

(5) Write Gate
This signal line enables the write current to the selected data head in the drive. When this signal is false (logical "1"), the Read Data from the disk is transmitted to the interface.

- (6) MFM Write Data (balanced transmission)
 This signal is a differential signal used to determine the flux change point of the data bit written on the disk.
 When +MFM Write Data goes more positive than -MFM Write Data while Write Gate is active, a flux change occurs.
 During a Read, this signal should remain inactive (+MFM Write Data should be more negative than -MFM Write Data).
- (7) Open Cable Detect
 A disconnected cable can be detected by sensing continuity between connector J1, Pin 16 and J2, Pin 7 which are shorted on the drive.
- (8) Motor-On Function
 When multiple drives are connected to a system, the +12V power supply may be overloaded. To prevent such a situation, a circuit was added which allows for power-up sequencing by the system.

 The controller may send an enabling signal, Motor-On, over the 'B' cable (Pin 5).

3.4.3 Output signals

(1) Index

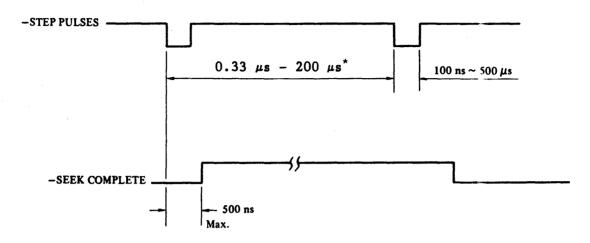
This is a pulse signal generated once per revolution of the disk in the selected drive.

- (2) Ready
 This signal is true or zero when the voltages are within specification and the spindle motor has reached nominal speed. This signal is true approximately 20 seconds after power on.
- (3) Track 0
 This signal indicates that the data heads are positioned at Cylinder 0.
- (4) Write Fault
 This signal is true when one of the following abnormal states occur during writing.
 - (i) Either +5 V or 12 V drop below specification.
 - (ii) Write current is not applied to the head while Write Gate is enabled.
 - (iii) Write Gate is enabled during a multihead select condition or while no head is selected.
 - (iv) Write current flowed but Write Gate is not applied.
 - (v) Off track condition occurs.
- (5) MFM Read Data (balanced transmission)
 This signal is a differential signal used to send the Read Data bit from the disk to the host side. When the Write Gate is inactive, the point at which +MFM Read Data goes more positive than -MFM Read Data represents a flux reversal on the track of the selected head.
- (6) Seek Complete
 This signal indicates that the selected data head is positioned at the requested track. This signal includes the settling time of the head, and when it is true, read/write operations are enabled.
- (7) Drive Selected
 When the Drive Select 1 4 matches the Drive Select keys (DRSL 1 4) on the drive side, the drive is selected.

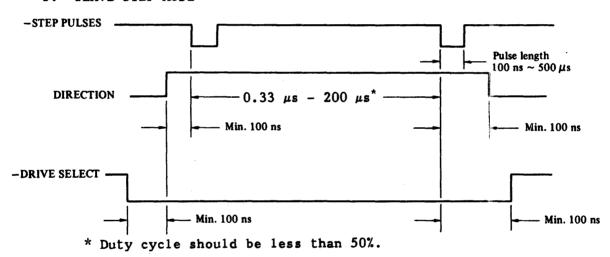
3.4.4 Timing specifications

(1) Seek timing

a. STEP/SEEK COMPLETE RELATIONSHIP

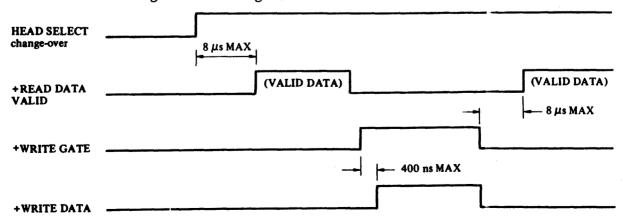


b. SLAVE STEP MODE

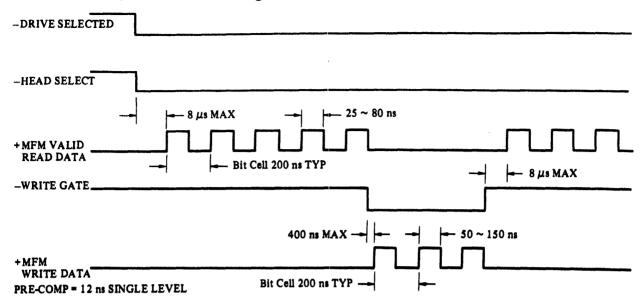


(2) Write/Read Data Timing

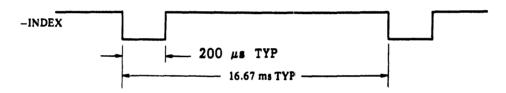
a. Head Change-over Timing



b. Read/Write Data Timing

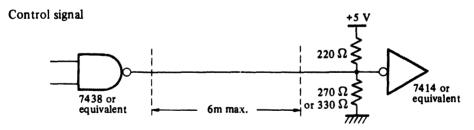


(3) Index Signal Timing



3.4.5 Driver/Receiver

The interface signals are terminated as in Figure 3.7. The total control cable length in a multi-drive configuration should not exceed the specification.



R/W signal

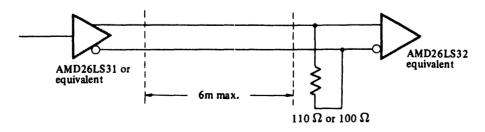


Figure 3.7 Driver/Receivers

3.4.6 Connector positions

a. ''A'' Connector (CNA)

| 1 | GND | * 2 | -HEAD SELECT 3 |
|----|-----|-----|-----------------|
| 3 | GND | 4 | -HEAD SELECT 2 |
| 5 | GND | 6 | -WRITE GATE |
| 7 | GND | 8 | -SEEK COMPLETE |
| 9 | GND | 10 | -TRACK 0 |
| 11 | GND | 12 | -WRITE FAULT |
| 13 | GND | 14 | -HEAD SELECT 0 |
| 15 | GND | 16 | (To 'B' - P-7) |
| 17 | GND | 18 | -HEAD SELECT 1 |
| 19 | GND | 20 | -INDEX |
| 21 | GND | 22 | -READY |
| 23 | GND | 24 | -STEP |
| 25 | GND | 26 | -DRIVE SELECT 1 |
| 27 | GND | 28 | -DRIVE SELECT 2 |
| 29 | GND | 30 | -DRIVE SELECT 3 |
| 31 | GND | 32 | -DRIVE SELECT 4 |
| 33 | GND | 34 | -DIRECTION |

Key slot: Between 4P and 6P

b. ''B'' Connector (CNB)

| - DRIVE SELECTED | | GND |
|-------------------|---|---|
| SERVED | 4 | GND |
| tor-On (Optional) | 6 | GND |
| o 'A' - P-16) | 8 | GND |
| ARE | 10 | SPARE |
| D | 12 | GND |
| ITE DATA | 14 | - WRITE DATA |
| D | 16 | GND |
| AD DATA | 18 | - READ DATA |
| D | 20 | GND |
| | IVE SELECTED SERVED tor-On (Optional) o 'A' - P-16) ARE D ITE DATA AD DATA | SERVED 4 tor-On (Optional) 6 o 'A' - P-16) 8 ARE 10 D 12 LITE DATA 14 D 16 AD DATA 18 |

Key slot: Between 4P and 6P

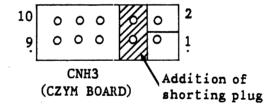
^{*}In the M224XAS drives, pin 02 of cable A is used as -HEAD SELECT 3. However, this signal line is used as -REDUCED WRITE CURRENT in some disk controllers. Therefore, if such a controller controls M2241/2AS (number of HEADs 4/7), a

head selected for a cylinder number more than a certain value causes REDUCED WRITE CURRENT to be sent which then interferes with normal read/write functions.

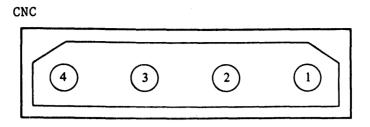
For this reason, the -HEAD SELECT 3 signal was changed to be plug selectable. The drive can now be controlled by the above-mentioned controllers.

Plug setting method

- (1) Shorting plug is inserted between CNH3-3 and CNH3-4. (Set when shipping from factory)
 "Interface cable A is used as -HEAD SELECT 3."
 (For M2243AS, the setting must be as above.)
- (2) Shorting plug is inserted between CNH3-1 and CNH3-2.
 "Interface cable A is used as -REDUCED WRITE CURRENT."
 (-REDUCED WRITE CURRENT function is automatically performed in the device.)



c. Power Connector



From cable side

| RTN |
|-----|
| RTN |
| |
| |

3.5 Theory of Operation

3.5.1 General description

The M224XAS is controlled by the microprocessor (MPU) (Intel 8031) and the sequence program stored in the EPROM (4K bytes). This section explains the operation of the M224XAS using block diagrams and the flowchart of the MPU sequence. Figure 3.8 shows the block diagram of the MPU control system.

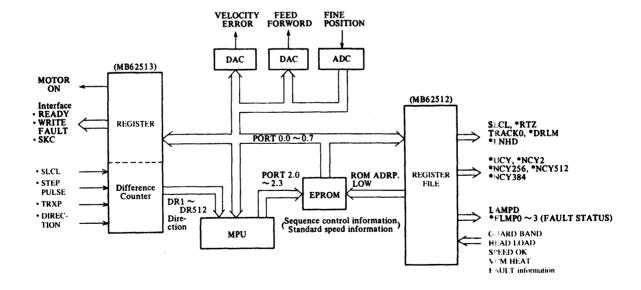


Figure 3.8 MPU Control System Block Diagram

3.5.2 Sequence

Figure 3.9 shows the flowchart from power-on, via drive ready, to the instruction executing sequence.

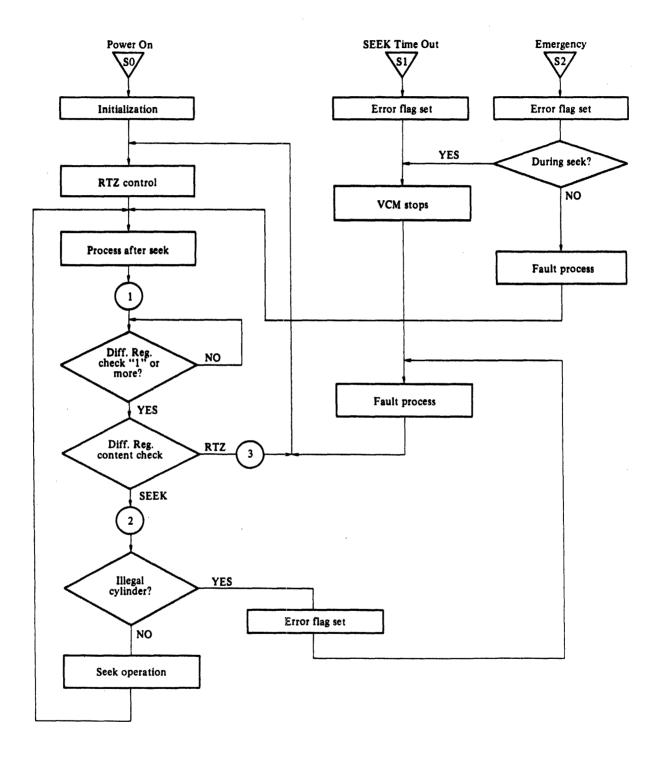


Figure 3.9 Control Flowchart

As shown in Figure 3.9, at power on, initialization (zero-clearing each memory and register) and RTZ operation of the initial seek sequence are performed. After RTZ operation, several processes (Ready, SKC and TRACK 0 process) are performed and the flow indicated by ① is entered. Difference register check is idling and awaits a seek instruction from the controller. As mentioned in the interface section, this register stores the number of the step pulses (actually difference value) under the slave mode, and sends it to the MPU. If that number is equal to or more than 754, the seek instruction is converted into an RTZ instruction. If less than 754, it is processed as a seek instruction.

Routines 2 and 3 are determined by the content of the difference register.

Difference < 754 enter into ② seek operation routine Difference > 754 enter into ③ RTZ operation routine

This flowchart is a basic operation. Therefore, when a time out or emergency condition occurs in this sequence, the normal sequence is stopped by interruption and the abnormal process routine is entered. As a result, the fault status is indicated by the status LED's. The MPU does not intervene directly with read/write operation.

3.5.3 Power-on sequence (initialization)

When +5V power is turned on, the MPU begins to operate and the following is performed:

- Reset each register in MPU
- Reset servo control register
- Reset each register of each sequence
- Reset each status register

Also, Motor On signal in the register in MB62513 is set, and the spindle motor control circuit begins to operate. Start up time is monitored by the 30 second counter in the MPU. Speed OK signal via MB62512 will be available if motor is up to speed within 30 seconds.

When Speed OK signal goes to ''l'', RTZ operation of the initial seek sequence is performed after 5 seconds. If the initial seek is not terminated within 30 seconds after powering—on, the spindle motor stops (Motor On signal is reset) and Fault code 03 is indicated by the fault lamp. This status is reset only by turning off and re—turning on the +5V power. Figure 3.10 shows the flowchart from power—on process to RTZ sequence.

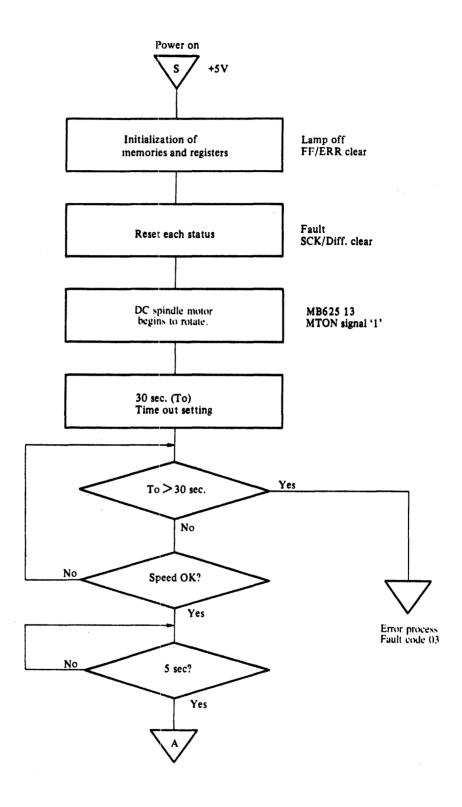


Figure 3.10 Power-On Sequence (Initialization)

(1) DC spindle motor control

Figure 3.11 shows the block diagram of the spindle motor control.

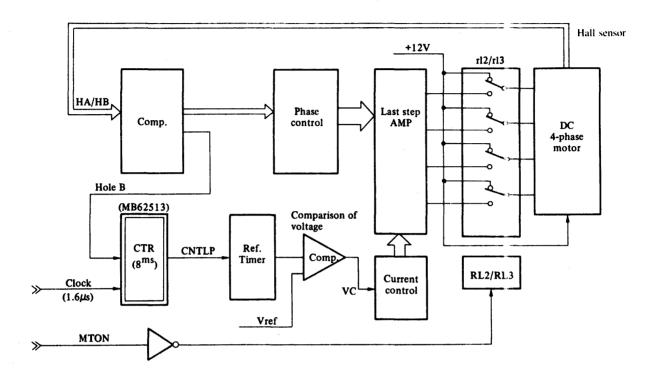


Figure 3.11 DC Motor Control Block Diagram

When powering off, the coil of the DC motor is shorted by the relay contact of the r12/r13 and the DC motor is in the dynamic brake status. Refer to Figure 3.12. Four lead wires of four coils and the common wire exit out of the DC motor and the common wire is connected to the +12V power. Two Hall sensors (HA, HB) are mounted in the DC motor to detect motor rotation.

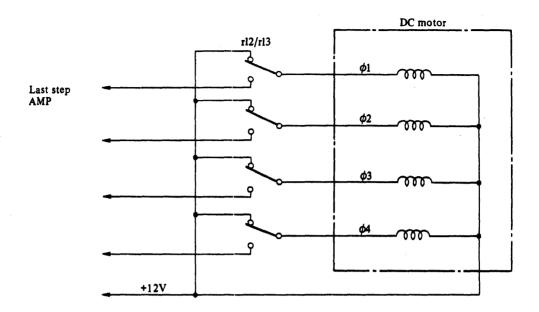


Figure 3.12 DC Motor Dynamic Brake

When the power is turned on and the MPU issues the motor start instruction (MTON), the contact of the relay (rl2/rl3) is switched to the last step AMP of the motor control circuit. The current control circuit flows the maximum current to one of four phases (ϕ 1 to ϕ 4) selected by the phase control circuit. The phase control is performed by the output signals (HA/HB) from the hall sensors. Output signal (HOLB) from the hall sensor operates the counter for controlling the DC motor rotation, and generates the signal (CNTCP) to the basic time (8 ms). This signal is used as the input signal of the basic timer circuit, and the voltage corresponding to the rotational time is the output of this circuit. This output voltage is compared with the basic voltage (Vref) and is used as the input signal to the current control circuit. The output voltage of the counter is controlled to produce the same level as the basic voltage in case of the steadystate rotation. That means, when the output of the voltage comparison circuit is near OV (steady-state rotation), the DC motor current control circuit stops the flow of current to the DC motor at the last step AMP. Figure 3.13 shows the timing chart.

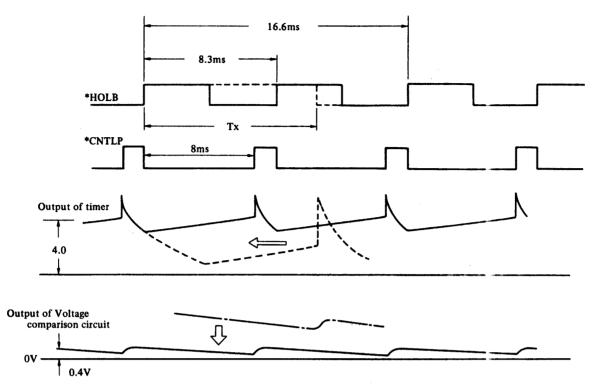


Figure 3.13 Steady-State Rotational Timing

When starting the DC motor, the waveform shown by the broken line in Figure 3.13 appears. This is the transition state. Figure 3.14 shows the waveform of the current control voltage Vc.

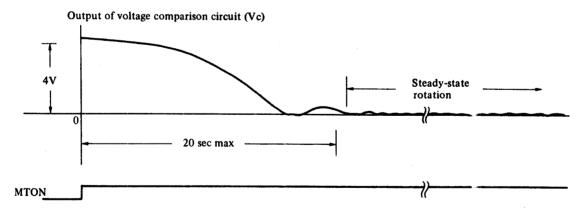


Figure 3.14 Current control voltage Vc

(2) Speed OK (SPDOK) signal sequence

HOLIN signal, given by differentially calculating the trailing edge of the output signal (HOLB) from the hall sensor, generates the CNTLP signal having the basic time (8 ms) in LSI MB62513. SPDOK signal is set when one—shot (approx. 1 ms) is triggered to the leading edge of CNTLP signal and the trailing edge of CNTLP signal that appears within this 1 ms. SPDOK signal is set at approximately 92% of the standard rotational speed, and after 5 sec, the initial seek (RTZ) is executed. Figure 3.15 shows the timing chart.

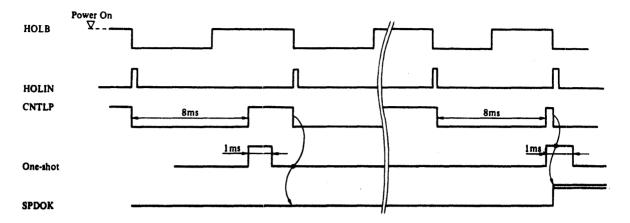


Figure 3.15 SPDOK signal timing chart

3.5.4 RTZ sequence

RTZ sequence makes the actuator move to Cylinder 0, and is executed in two cases:
(A) Initial sequence after power on, (B) receiving an RTZ instruction.

In the RTZ sequence, the following process is executed.

- (1) Time out setting (preparation of interruption)
- (2) SKC resetting
- (3) DRLM setting

Next, confirmation of HDLD, i.e. the head is already located in the servo area, is achieved. If HDLD is 0, moving direction becomes forward and the actuator is moved to outer direction at high speed until IGB2 is detected. After IGB2 is detected, the actuator is switched to low speed, and is controlled until IGB1 becomes false. When IGB1 becomes false, the two track seek routine begins, (IGB1 becomes false two tracks before Track 0.) When HDLD is 1, it means that the heads are in the servo area. In this case, if the heads are in IGB2 area, the flow enters the above routine. If in another area, it is moved in the reverse direction (inner) at high speed until IGB1 is detected. After IGB1 is detected, the actuator is switched to low speed, and is controlled until IGB2 is detected. After detecting IGB2, the flow enters the sequence already mentioned. If a fault occurred during this sequence it is indicated by the LEDs on the PCB.

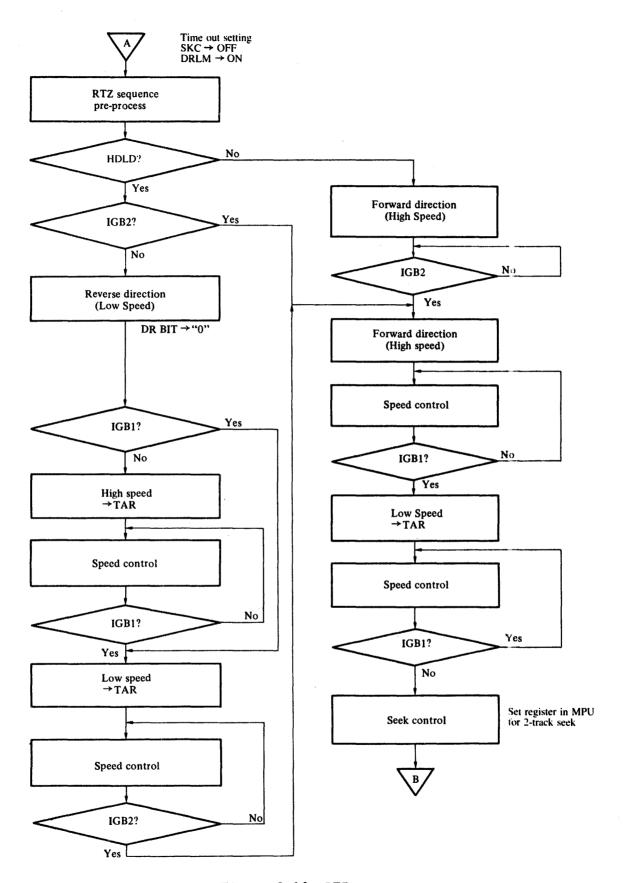
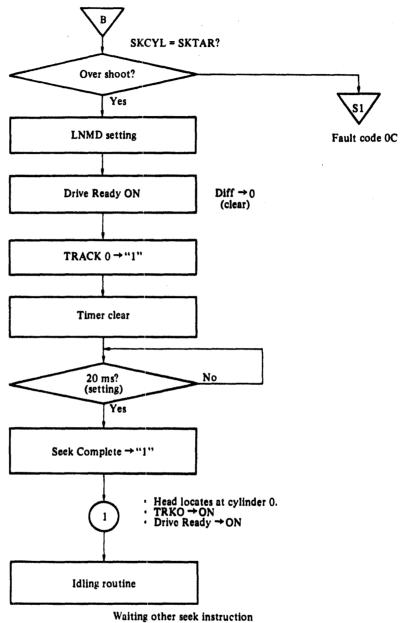


Figure 3.16 RTZ sequence



SKCYL: Current address Note:

> SKTAR: Target address TAR: Target speed

Figure 3.17 Post Seek Sequence

3.5.5 Seek sequence

The seek sequence consists of the seek pre-process, the seek speed control and the seek post-process.

In the seek pre-process, the following is executed and controlled by the direction and number of step pulses given by the interface.

- Illegal cylinder check
- DRLM, SKC, *NCY1, *NCY2 setting
- Seek-time-over timer starting
- Initial feed forward value setting

In the seek speed control, the current position is read and the difference value to the target cylinder is calculated. If the difference is 0, the flow enters into the seek post-process. If the difference is 1, the speed control is performed. The speed control is achieved by the following procedure:

- Calculate the difference between the current location and the last location $(\Delta v = \Delta x / \Delta t, \Delta t)$; calculated cycle time).
- Read the target speed corresponding to the difference value from EPROM.
- (3) Set the speed difference between the current speed and the target speed.

The current location is determined by analog-to-digital convertion of the -Fine Position signal which indicates the detailed location between tracks. The difference counter stores the track crossing pulses (TRXP).

To stabilize decreasing speed control of seek, Feed Forward signal is active through the DA converter. This signal is not output when the difference value is more than 128, and is active from the point that the current speed exceeds the target speed until seek stops when the difference value is less than 128. When the difference value is less than 20, the feed forward value is decreased in each calculating cycle. Therefore, it is available to decrease the speed gradually.

The seek post-process is the same as RTZ. Figure 3.18 shows the seek sequence flowchart.

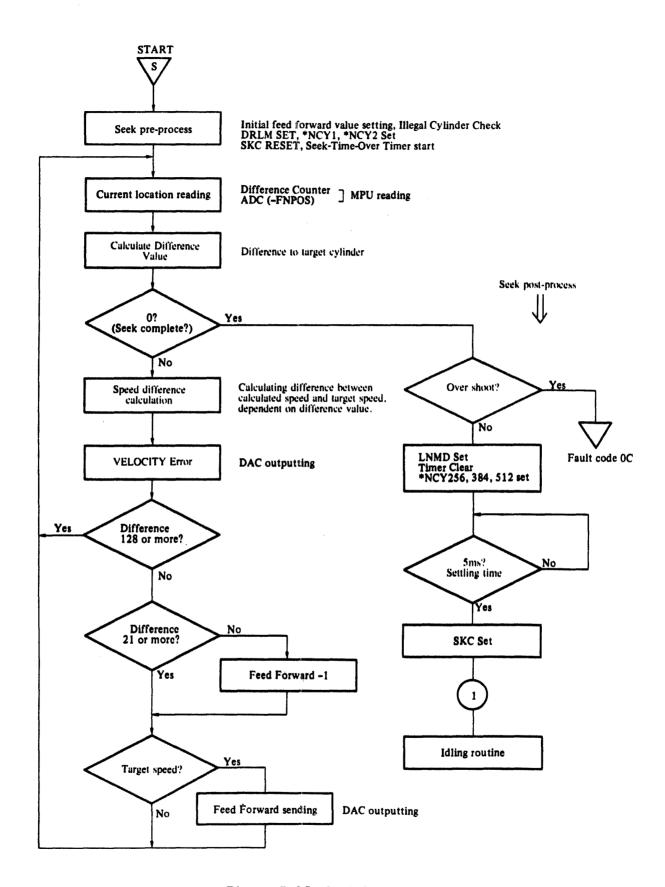


Figure 3.18 Seek Sequence

3.5.6 Seek control circuit

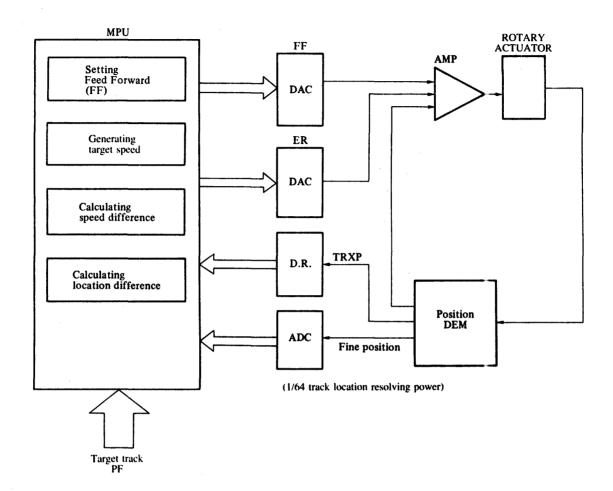


Figure 3.19 Seek Block Diagram

Figure 3.19 shows the block diagram of the seek circuit. The microprocessor (MPU) sets the feed forward value and enables current to the actuator with the ER signal. This feed forward value is an assumed value set with available information. The forecast value of the necessary current to move the head to the target track is given by the circuit different from the feed-back circuit, and the speed difference is set to 0 through the decreasing speed area, and the actual speed is made to coincide with the standard speed. Therefore, the difference between the actual speed and the target speed occurs. If it is necessary to correct the actual speed, that information will be the error information given by the feed-back circuit. Figure 3.20 shows the profile of speed and current during seek. Figure 3.21 shows the waveform of -FNPOS and Error signal.

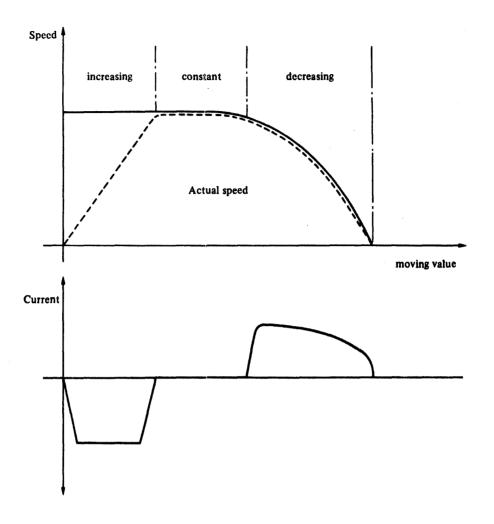
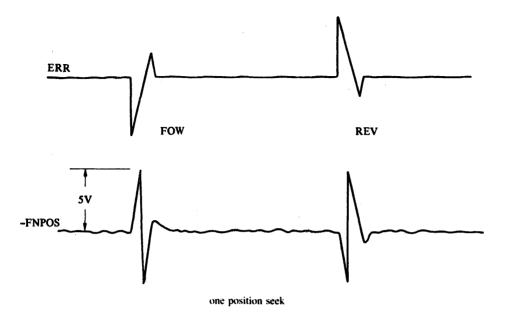


Figure 3.20 Seek Current



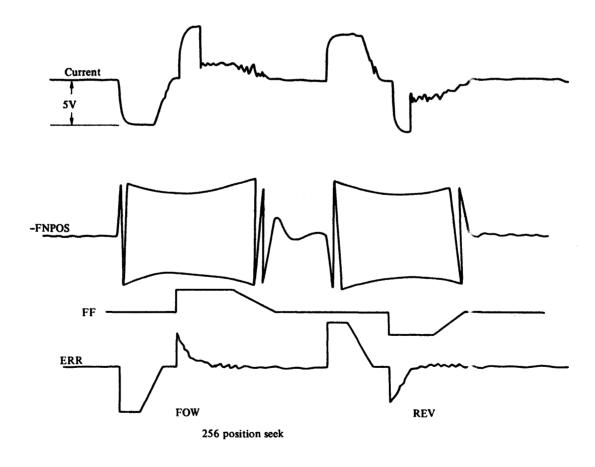


Figure 3.21 Waveforms During Seek

3.5.7 Servo demodulation circuit

As mentioned in subsection 3.4.1, the two-phase information written on the lowest order disk is read by the servo head and is sent to the AGC Amp. This Amp supplies a constant output even if the input is changed. This output is sent to a low-pass filter (LPF). The LPF will remove high frequency noise. This output is converted into Servo (CNH2-7) signal having a 10 Vp-p.

The servo signal is converted into a pulse by the level slice comparator. The trailing edge of the sliced pulse triggers a one-shot 100 ms pulse and another trigger one-shot (550 ms window) for separating servo pulses. Servo pulse (SVP) is generated by these two signals. SVP is a pulse having a four byte period. Noise on SVP is removed by gating with a 5us one-shot. SVP is triggered by a 3us one-shot. CPL signal is sent to a PLO (phase locked oscillator). CPL signal is phase-compared with CT7 signal, the resulting signal is converted into a voltage in the charge pump circuit (4044), and sent to the VCO (voltage control oscillator) through a filter. Clock signal PLOIF from VCO is a one bit-cell clock synchronized with servo pulse (SVP). PLOIF clock is sent to the timing counter in LSI MB15238.

The timing counter generates the following signals using PLO1F signal and the signal generated by dividing PLO1F signal.

- *GT1, *GT2, *GT3, *GT4 necessary for generation of peak holding servo information
- *CT15 initial setting of dividing counter
- phase comparing with SVP

Servo signal is also sent to the peak hold circuit, and peaks of ODD1, EVEN1, ODD2, EVEN2 are held by *GT1 - GT4 signals. Output of each peak hold circuit is sent to the summing amplifier and two differential amplifiers through the buffer amplifier, and generates AGC voltage and two-phase position signal, POSN (Position Normal) and POSQ (Position Quadruture). Figure 3.23 shows the timing chart of the PLO circuit and the peak hold circuit. Figure 3.24 shows the timing chart of the fine position generation.

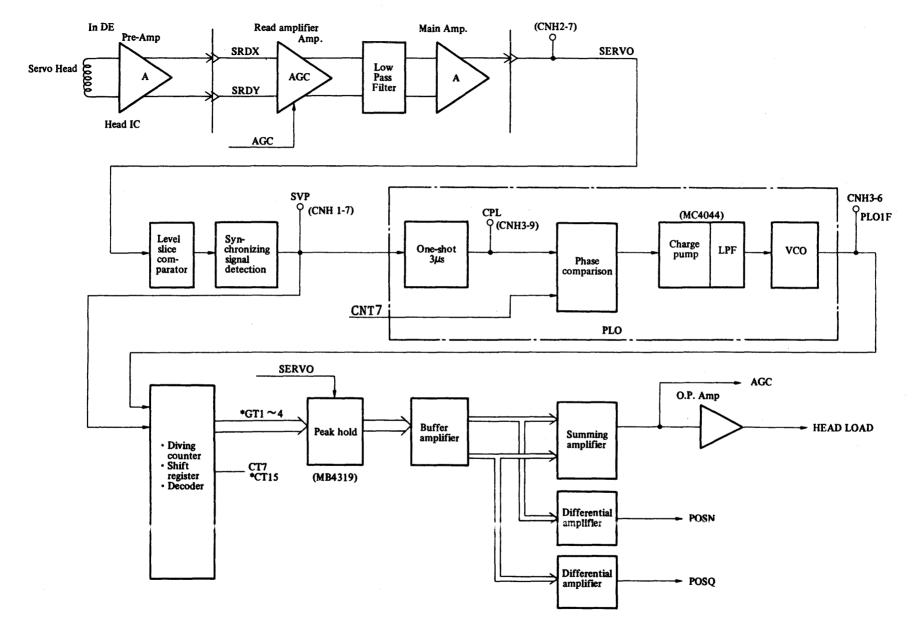


Figure 3.22 Demodulation Circuit

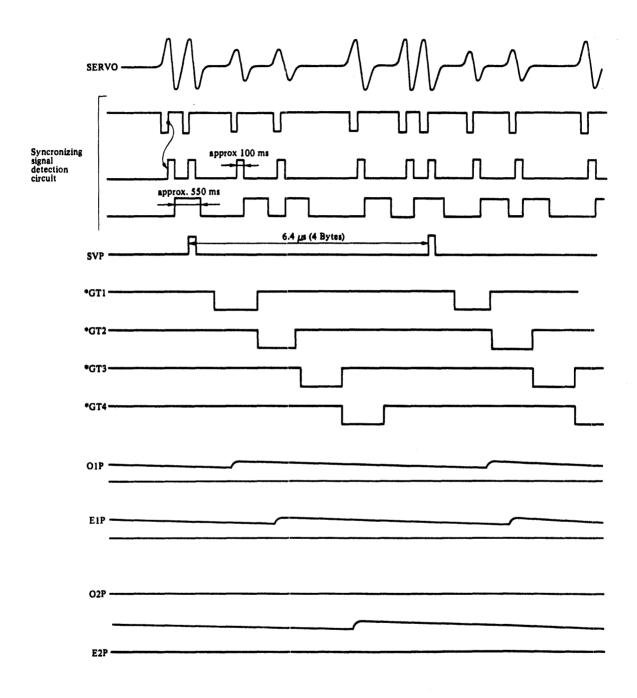


Figure 3.23 PLO/Peak Hold Timing

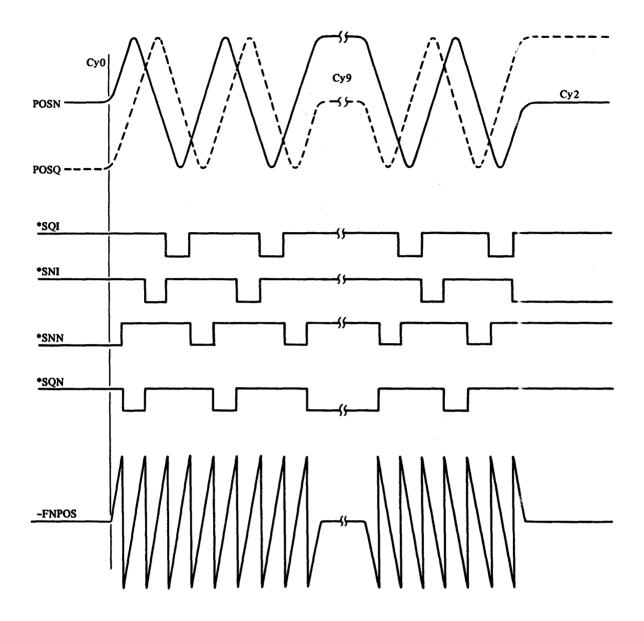


Figure 3.24 Fine Position Generation

3.5.8 Fault detection during seek

(1) VCMHT (VCM heat detection circuit); (Fault code 02)

If abnormal current flows into the VCM, the VCM heat detection circuit detects it and sends VCMHT signal to the MPU.

(2) Seek timeout (Fault code 09)

The timer/counter in the MPU is set to 0.8 sec before starting a seek. During this time (0.8 sec), if seek is not completed, internal interruption of MPU occurs and flow shifts from the seek operation routine to the time over routine.

(3) Over-shoot check (Fault code OC)

After a seek, overshoot is checked. This is detected from difference between the current position and the target position.

(4) Guard band detection (Fault code OA/OB)

This fault indicates that guard band (IGB1, OGB) is detected during seek operation. It is also reported when guard band is detected during track following (LNMD).

Each fault is coded during sequence, and is indicated by FLMP 0 - 3.

3.5.9 Index, guard band detection circuit

As mentioned in the servo track format section, the index bit pattern, including the missing index pulse, is in the servo pattern. Index, IGB1, IGB2 and OGB are detected by combining the index bit pattern and the normal bit pattern. The pattern detection is performed by sending PLOL signal. It is reset by SVP signal and set by CNT7 signal, through a shift register in MB15238 using the servo pulse (SVP) signal that is missing in the index bit pattern. Figure 3.25 shows the index detection timing.

In case of IGB1, IGB2 and OGB, the pattern occurs every 260 bytes. If the servo head is positioned in the guard band area, the guard band signal becomes a continous signal because if the guard band pulse is inserted within 272 bytes again, guard band signal is kept in MB15238.

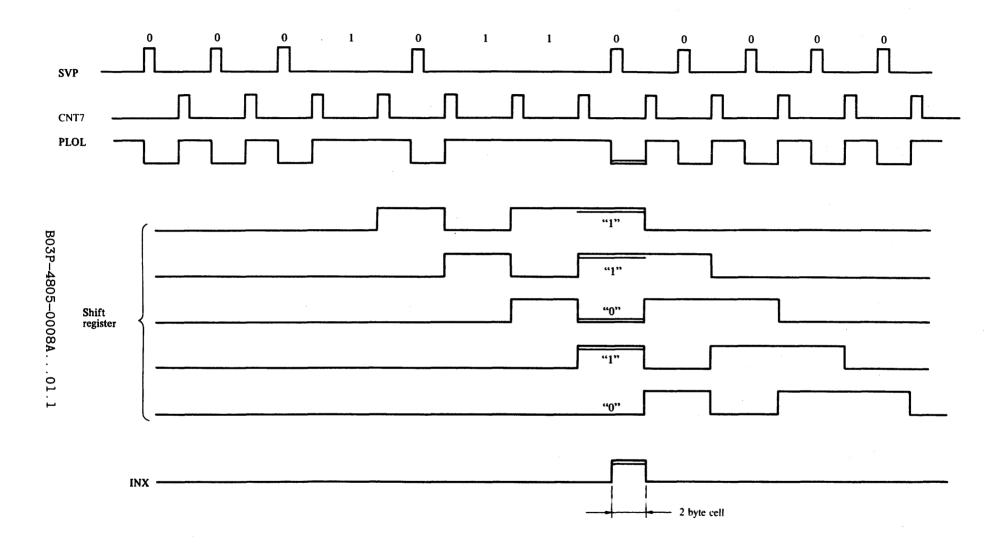


Figure 3.25 Index Signal Detection Timing Chart

3.5.10 Read/Write circuit

(1) General description

The read/write circuit consists of the head IC section inside the DE, the head select circuit, the write circuit and the read circuit. Figure 3.26 shows the block diagram of the read/write circuit.

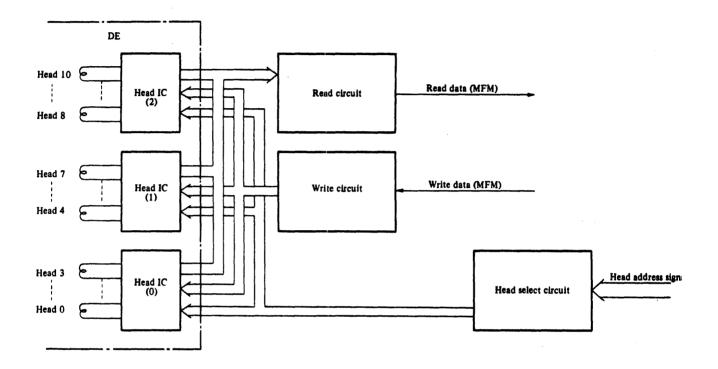


Figure 3.26 Read/Write Circuit Block Diagram

(2) Head IC section

The head IC section consists of 4 channel circuits, having the pre-amplifier and write amplifier. Each channel is connected to a data head. M2241AS, M2242AS and M2243AS have one, two and three head ICs inside the DE, respectively.

(3) Head select circuit

This circuit selects one head to record/read data by decoding Head Select 0 - 3 from the controller. This circuit further selects a head IC and finally a specific head.

(4) Write circuit

Figure 3.27 shows the block diagram of the write circuit.

a. Write amplifier

This is a current source detection circuit that determines the write current value of the head. This circuit is set on/off with write command signal (Write Gate) from the controller. The current value is changed according to the cylinder address of the head to control the optimum current to the head. If an error is detected in the WRITE FAULT of POWER LOSS detection circuit, the current source is cut off unconditionally.

b. Write driver

Write data received from the controller consists of write data pulses modulated to MFM. The write driver receives current from the write amplifier and controls the current to be sent to the data head according to the WRITE DATA PULSE.

c. WRITE FAULT detection circuit

This circuit detects write faults during the write operation. A fault will set the Fault Latch and send Write Fault to the controller in the following cases.

- (a) When write current is not supplied to the head.
- (b) When a non-select or multiselect state occurs in heads.
- (c) When Write Gate is received in one of the following states:
 - Not Ready state
 - Before seek complete is set
- (d) When the DC voltage is abnormal
- (e) When an Off-track condition occurs.

d. POWER LOSS detection circuit

When the power is switched on/off or a power hit occurs, abnormal current may flow in the head because of a disturbance of the logic circuit, resulting in destruction of data on the disk. Therefore, the POWER LOSS detection circuit monitors the DC voltage level. The voltage clamps the write amplifier current source before the logic circuit is disturbed to protect the head from abnormal current.

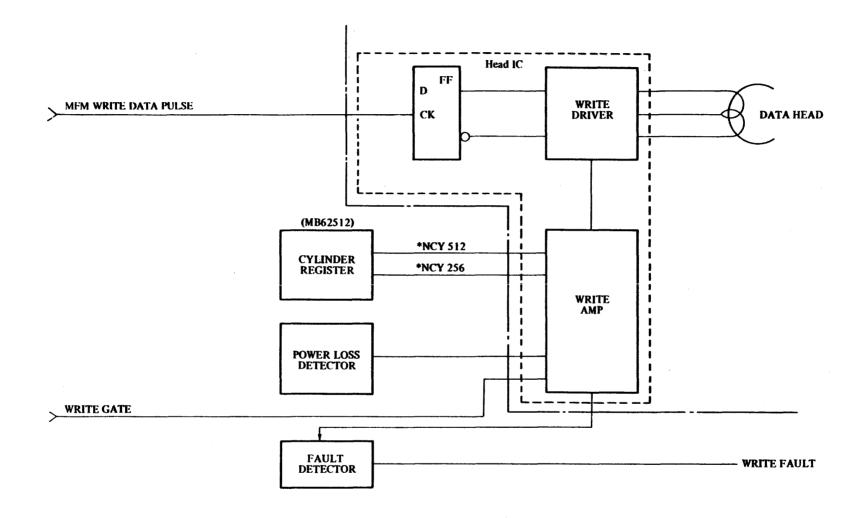


Figure 3.27 Write Circuit Block Diagram

(5) Read circuit

Figure 3.28 shows a block diagram of the read circuit and Figure 3.29 shows its waveforms.

a. Pre-amplifier

This is included within the head IC. Read signal generated by flux reversals on a disk and detected head output signal are input to the pre-amplifier, where they are amplified approximately 100 times.

b. Filters I and II

These filters eliminate high-frequency noise from read signals amplified by the pre-amplifier and main amplifier. The filter characteristics are changed according to the cylinder address of the head to compensate for the difference of head output signal characteristics between outer and inner cylinders.

c. Differentiation circuit

The peak position of read signal output from the pre-amplifier indicates the flux reverse point. This circuit, including CR, converts flux points to zero-cross points.

d. Main amplifier

This circuit amplifies signals differentiated by the differentiation circuit approximately 200 times.

e. Pulse shaper

This circuit detects zero-cross points of the differentiated waveform amplified by the main amplifier, then converts them to TTL level.

f. Shoulder noise elimination circuit

A read waveform sent from the head has shoulders shown in Figure 3.29. Differentiation of this waveform shows that the shoulders are close to the zero-cross line. External noise may add noise pulses to pulse shaper outputs.

The shoulder noise elimination circuit selects signal and noise pulses according to the pulse widths, and eliminates pulses narrower than the specified pulse width as noise pulses.

g. Waveform shaping circuit

This circuit generates raw data having the specified pulse width from the leading and trailing edges of the shoulder noise elimination circuit outputs.

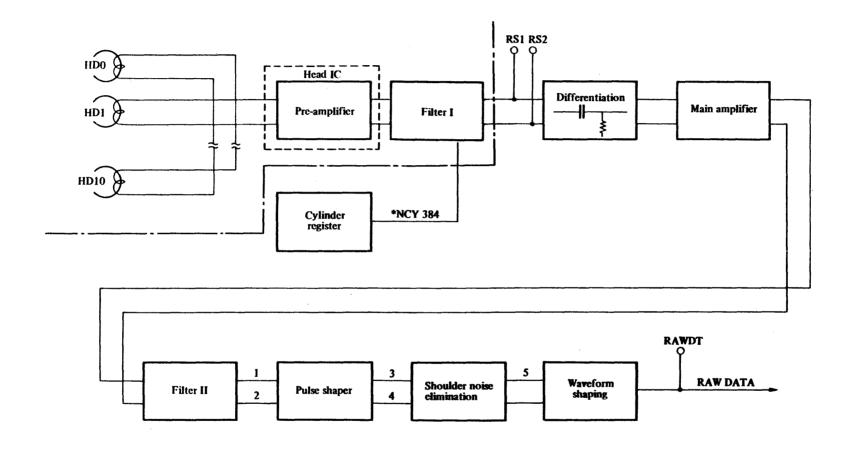


Figure 3.28 Read Circuit Block Diagram

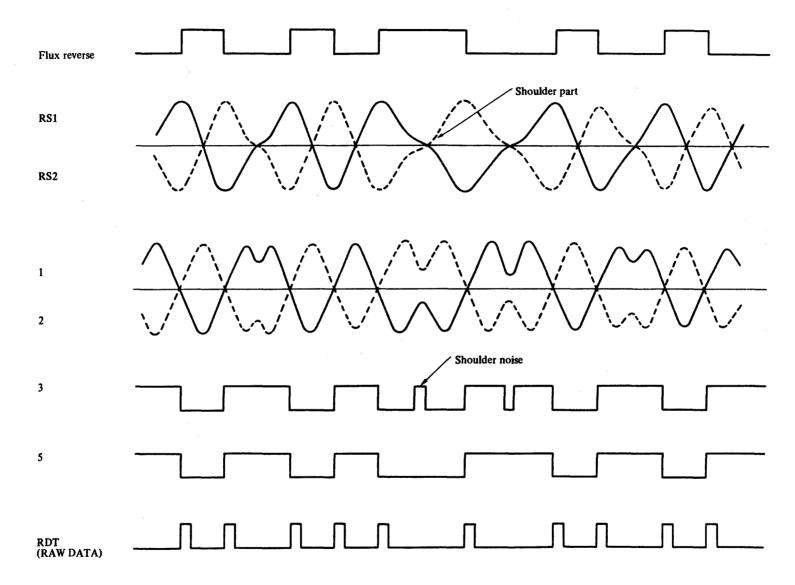


Figure 3.29 Read Circuit Waveforms

3.5.11 Fault detection

When a fault is detected, the fault is reported to the controller as Device Fault (FAULT), and detail status is coded by the MPU and displayed on LEDs for maintenance. Table 3.2 lists fault codes and description of fault.

Table 3.2 Fault status

| Fault code | Description of Fault |
|------------|--|
| 01 (0001) | Abnormal rotation of DC spindle motor |
| 02 (0010) | Abnormal current into VCM |
| 03 (0011) | Initial seek time out |
| 04 (0100) | Control check (write during seek) |
| 05 (0101) | Write check l (abnormal voltage) |
| 06 (0110) | Write check 2 (off track) |
| 07 (0111) | Write check 3 (Write current abnormal) |
| 08 (1000) | Write check 4 (multiselect) |
| 09 (1001) | Seek time out |
| OA (1010) | Guard band during seek |
| OB (1011) | Guard band under linear mode |
| OC (1100) | Overshoot |
| OD (1101) | Abnormal address check |
| OE (1110) | Head is positioned outside of servo area |
| OF (1111) | Undefined |

Note: A 'l' in parentheses represents a light which is on. Fault lamp (FLMP) 0 is the LSB and FLMP 3 is the MSB.

3.5.12 -12V power generation

The -12 volts is derived from the +12 volts for servo control. This is accomplished by the DC-DC converter circuit in the power amplifier PCB (TVSM).

CHAPTER 4 TROUBLESHOOTING

4.1 General Description

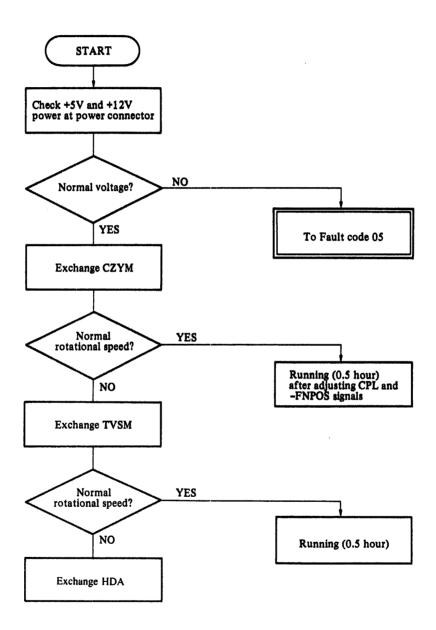
This chapter covers troubleshooting procedures for the M224XAS to locate problems in the PCBs and drive mechanisms. LEDs (Fault LEDs) on the PCB indicate any abnormal status, except data error during read operation.

4.2 Troubleshooting

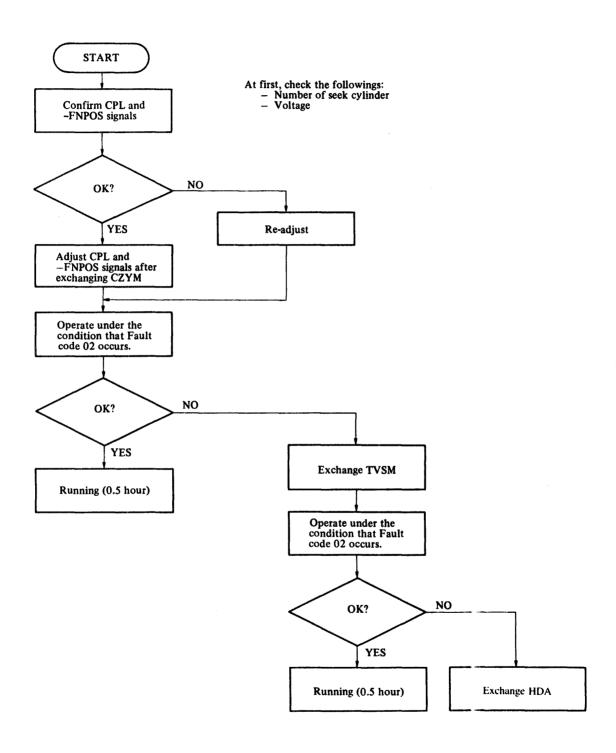
Troubleshooting procedures for abnormal status indicated by LED's (Fault code 01 to 0E) and read errors are shown in this section by the use of a flowchart.

Fault Code 01 (0001)

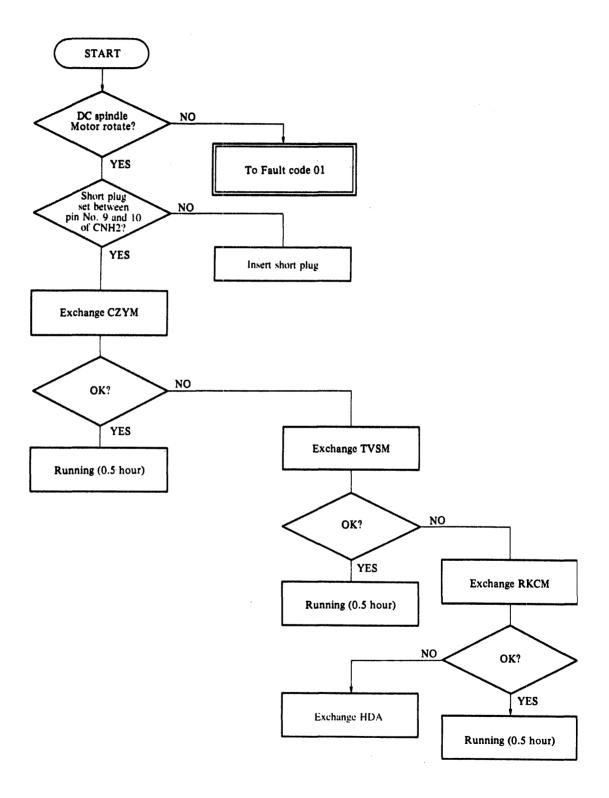
Rotational speed of DC motor was less than 90% of standard speed, or DC motor did not rotate.



Abnormal current flow to VCM (VCMHT).

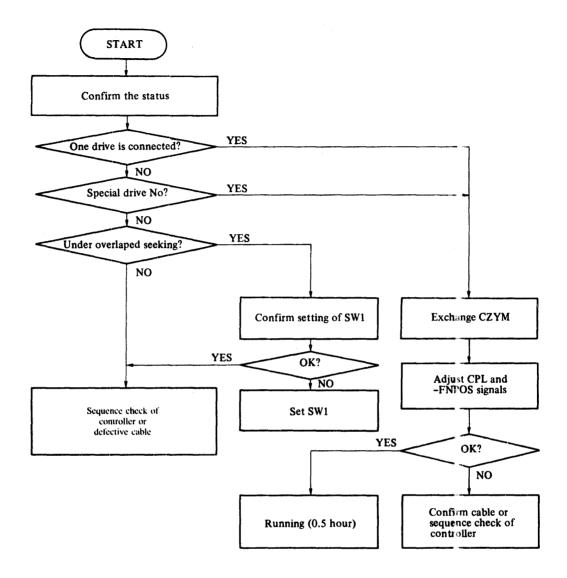


Initial Seek Time-Out



Fault Code 04 (0100)

Write command issued during seek operation.

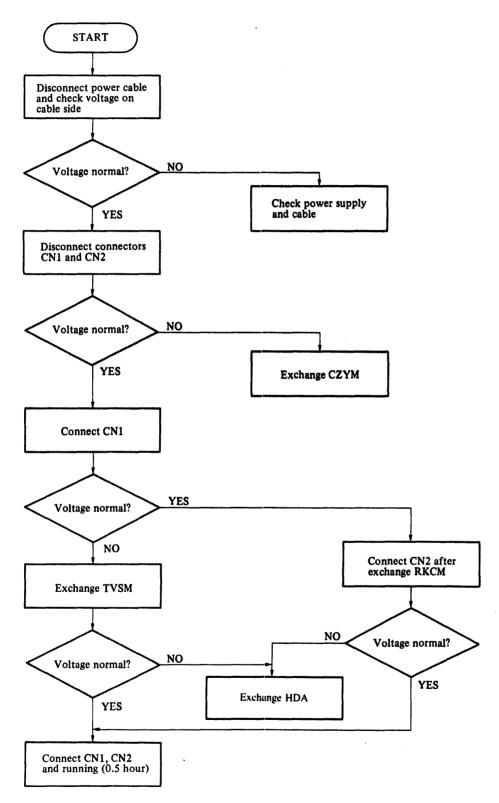


Note: Causes of this fault code are as follows.

- Abnormal sequence of controller
- Defective CZYM
- Defective interface cable

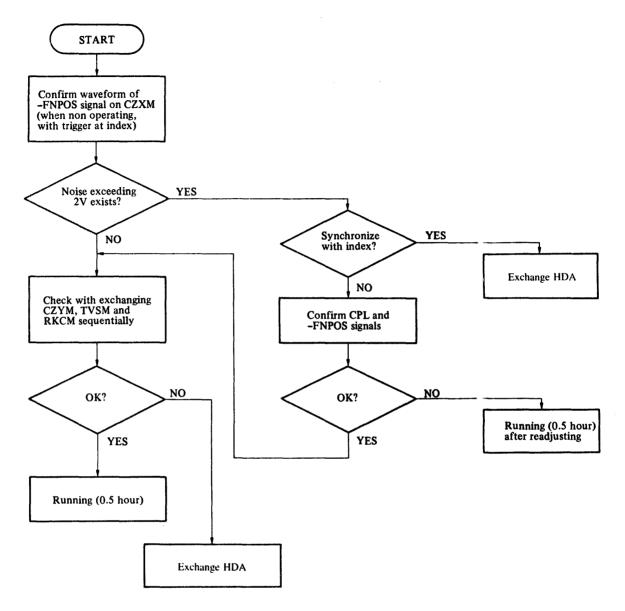
Fault Code 05 (0101)

Either +12V or +5V power is less than 80% of specified voltage during write operation.



Fault Code 06 (0110)

Off track occured during write operation.

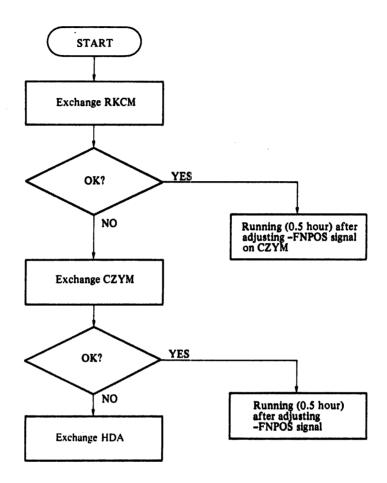


Note: This fault may occur with excessive external shock or vibration.

Fault Code 07 (0111)/08 (1000)

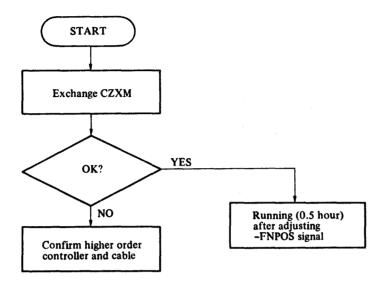
Write current was abnormal.

Two or more heads were selected during write operation.



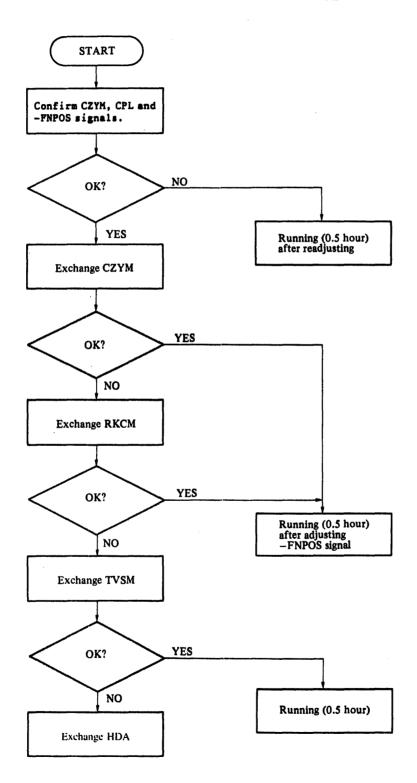
Fault Code OD (1101)

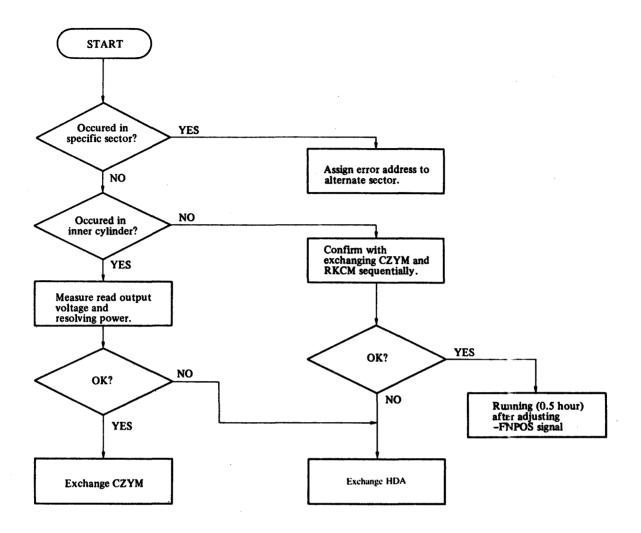
Seek command issued to cylinder other than cylinder 0 to 753.



Fault Code 09/0A/0B/0C/0E

| Seek timeout error. | 09 |
|---|----|
| Guard band was detected during seek operation. | 0A |
| Guard band was detected under linear mode. | OB |
| Over shoot check. | 0C |
| After ready state, head load signal became false. | 0E |





CHAPTER 5 MAINTENANCE

5.1 General Description

This chapter describes the maintenance procedure for the M224XAS. It consists of general information, preventive maintenance, adjustments and electrical verification.

5.2 General Information

5.2.1 Power on/off

- (1) After a visual check of the drive, verify power by turning the drive ''ON'' and ''OFF''
- (2) Following maintenance, confirm all PCB's are in proper location and secure.

5.2.2 Cables/Connectors

Do not remove or install any cables or connectors with power on.

If a cable has been installed or re-installed, verify that it is connected properly.

5.2.3 Parts Replacement

- (1) Use a suitable tool for each part.
- (2) Save all parts removed, such as screws, brackets, etc.
- (3) Secure all parts after replacement.

5.2.4 Test/Check Out

- (1) Run appropriate tests to verify operation.
- (2) Record repair and test results.

5.3 Maintenance Tools and Equipment

Maintenance tools and equipment listed in the following table are for special use, for example trouble recovery, they are not required for routine maintenance.

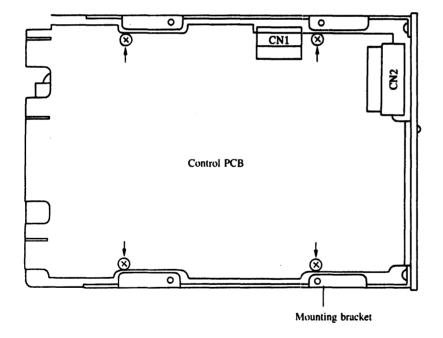
| Description | Specification |
|----------------------------|--------------------------------|
| Oscilloscope | Tektronix 475 or equivalent |
| Scope Probe (X 10) | Tektronix P6053B or equivalent |
| Digital multimeter | |
| Screwdriver for adjustment | |
| Screwdriver | Number 2 Phillips |

5.4 Preventive Maintenance

Preventive maintenance is not required.

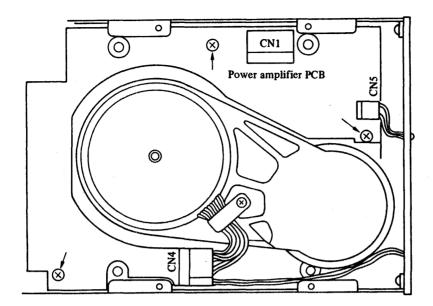
5.5 PCB Removal

(1) Control Y CZYM PCB



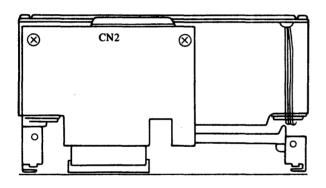
- 1. Remove 4-M3 screws
- 2. Disconnect CN1
- 3. Disconnect CN2
- 4. Remove PCB

(2) Power amplifiers TVSM PCB



- 1. Remove 3, M3 screws
- 2. Disconnect CN5 and CN1
- 3. Disconnect CN4 while lifting CN1 side of PCB
- 4. Remove PCB

(3) Read amplifier C RKCM PCB



- (1) Remove front panel from mounting brackets.
- (2) Remove 2, M3 screws
- (3) Disconnect CN2 while lifting the side of the PCB opposite CN2. At this time, be careful not to break the flex cable/connector.
- (4) Remove PCB.

5.6 Verification and Adjustment

5.6.1 Location of test points, adjustments and fault indicators.

Figure 6.1 shows the test points and adjustments on the control (CZYM) PCB.

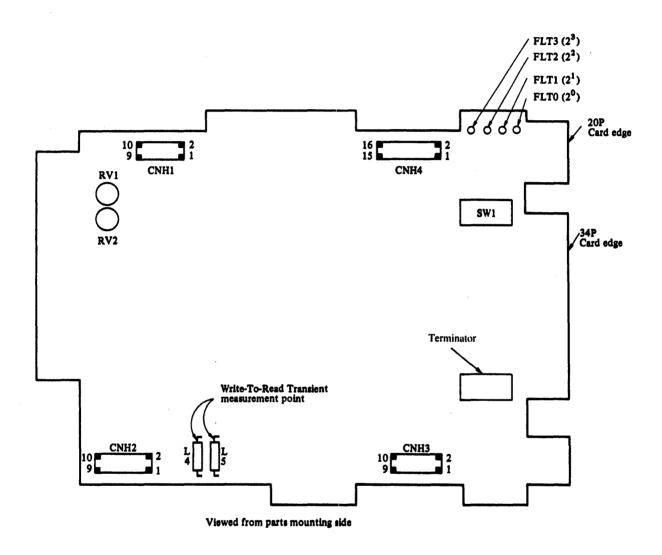


Figure 5.1 Location of Test Points and Adjustments

5.6.2 Signals on test points

(1) CNH1

| 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 |
|--------------|--------|-----|-----|--------|-------|-----|-----|-----|----|
| OFF TRACK | +FNPOS | P2F | SVP | -FNPOS | N+Q>0 | N>Q | PSQ | PSN | 0V |

(2) CNH2

| 10 | 8 | 6 | 4 | 2 |
|------|-------|-----|-----|-----|
| PWDR | PWDR | SSG | CD1 | RS1 |
| 9 | 7 | 5 | 3 | 1 |
| PWDR | SERV0 | 5VA | RS2 | ov |

Note: Pin No. 09 and 10 must be shorted with the shorting plug.

(3) CNH3

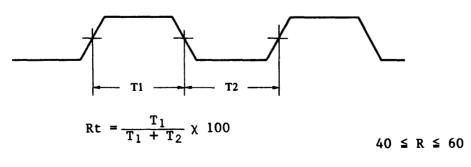
| 10 | 8 | 6 | 4 | 2 |
|-------|-----|-------|---|-----|
| *DRLM | RRD | PLO1F | - | 00 |
| 9 | 7 | 5 | 3 | 1 |
| CPL | - | WDP | _ | +5V |

(4) CNH4

| 16 | 14 | 12 | 10 | 8 | 6 | 4 | 2 |
|-------|-------|-------|------|------|---|----------|-------|
| DIAG1 | DIAG2 | WGT | FLT3 | FLT1 | - | * WGT | SKC |
| 15 | 13 | 11 | 9 | 7 | 5 | 3 | 1 |
| ov | - | WFALT | FLT2 | FLTO | - | DIRCT | INDEX |

5.6.3 Confirmation of P2F signal

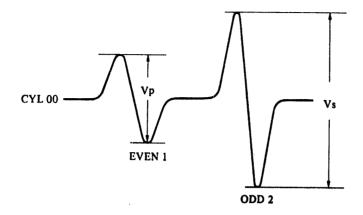
Measure pin No. 8 of the test point CNH1, and confirm the following



 $T_1 + T_2 = 100 \text{ ns } \pm 0.5\%$

5.6.4 Confirmation of servo signal

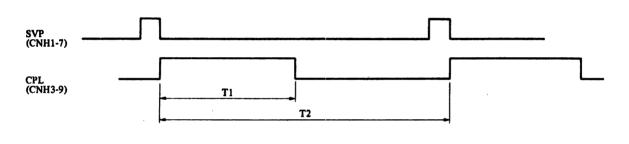
Measure pin No. 7 of the test point CNH2, and confirm the following.



$$V_s = 8V \pm 0.5V$$

 $V_p = 4V \pm 0.5V$

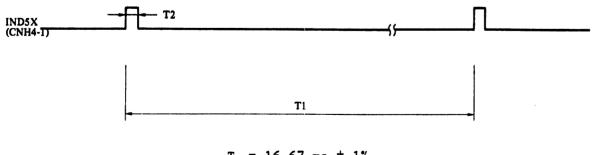
5.6.5 Confirmation of CPL signal



$$T_1$$
 = 3.0 µs ± 0.1 µs T_2 = 6.4 µs ± 0.2 µs

If T_1 is out of specification, adjust RV1.

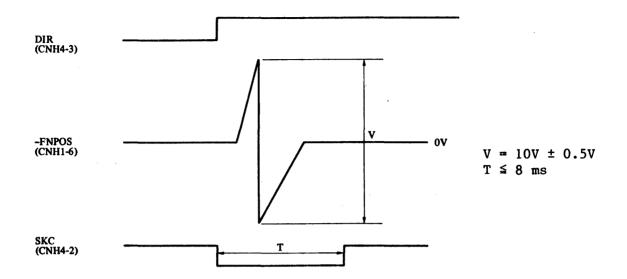
5.6.6 Confirmation of Index signal



$$T_1 = 16.67 \text{ ms} \pm 1\%$$

 $T_2 = 200 \mu \text{s} \pm 50\%$

5.6.7 Confirmation of -FNPOS signal



Note: 1. Level of -FNPOS signal can be adjusted by RV2.

- 2. Adjustment and confirmation are performed by 1 track seek from cylinder 0 to cylinder 1.
- 3. When replacing HDA, CZYM or RKCM, -FNPOS signal must be adjusted.
- 4. Adjust the voltage to nominal value.

5.6.8 Confirmation of +12V power

Measure the lead of inductance L2 on CZYM and confirm the following specification is satisfied.

-12V ±10%

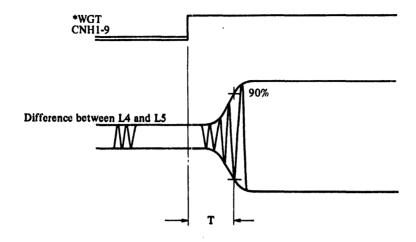
5.6.9 Confirmation of read output level

Observe differential at test points RS1 and RS2, output voltage V_1t and V_2t of 2t/lt, and resolving power (Res = V_1t/V_2t) must satisfy following specification.

- (1) CYL 0 $V_1\tau \ge 40 \text{ mV Res} \ge 55\%$
- (2) CYL 753 $V_2\tau \le 400 \text{ mV}$ Res $\le 98\%$

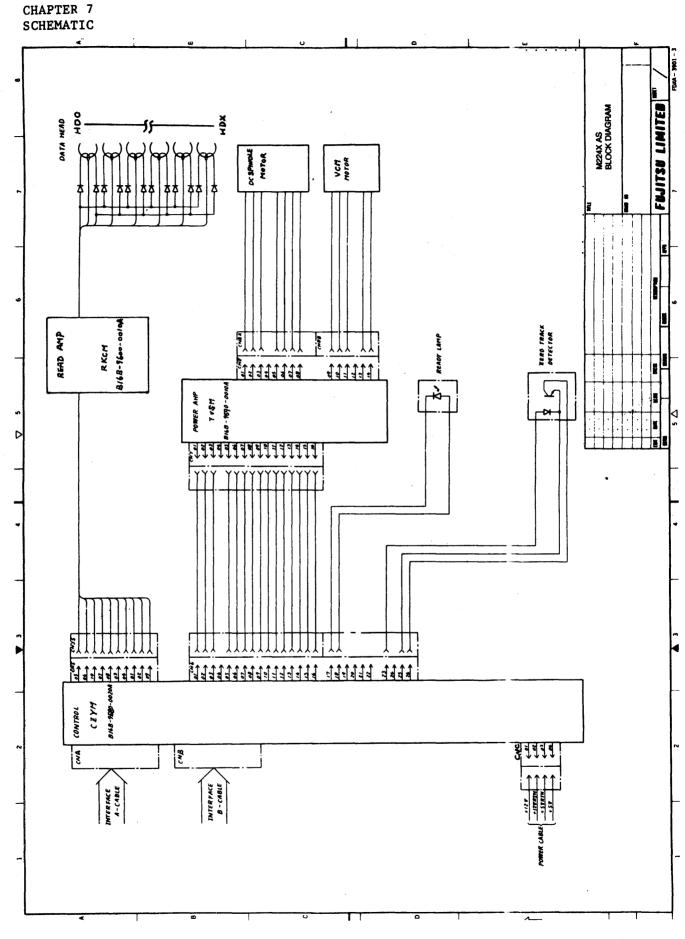
5.6.10 Write-read transient

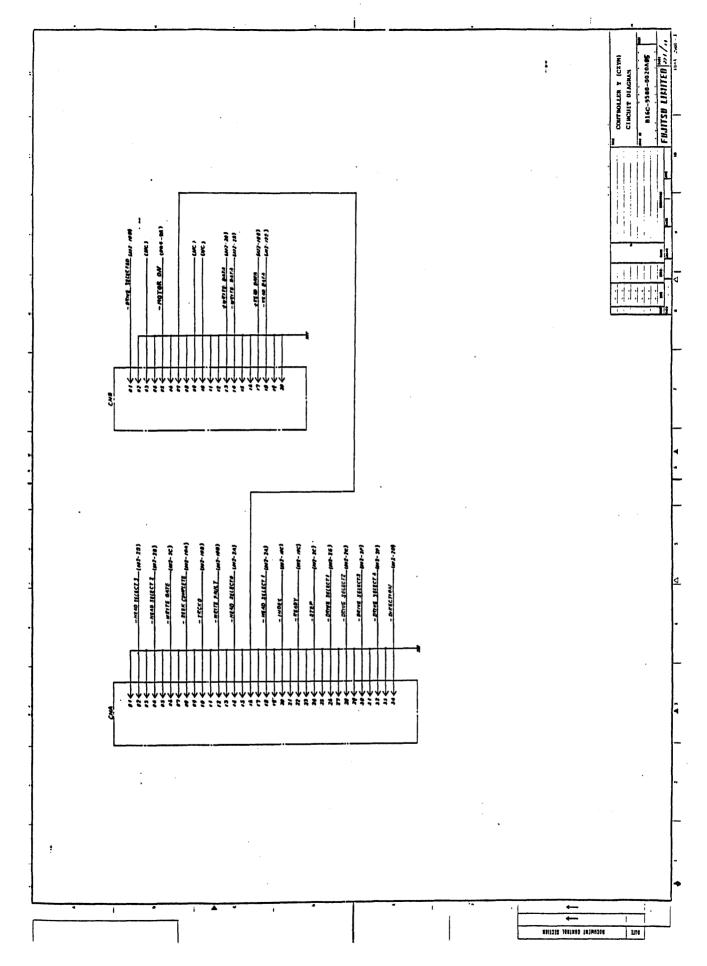
Transient is less than 8µs when writing the data with data write command.

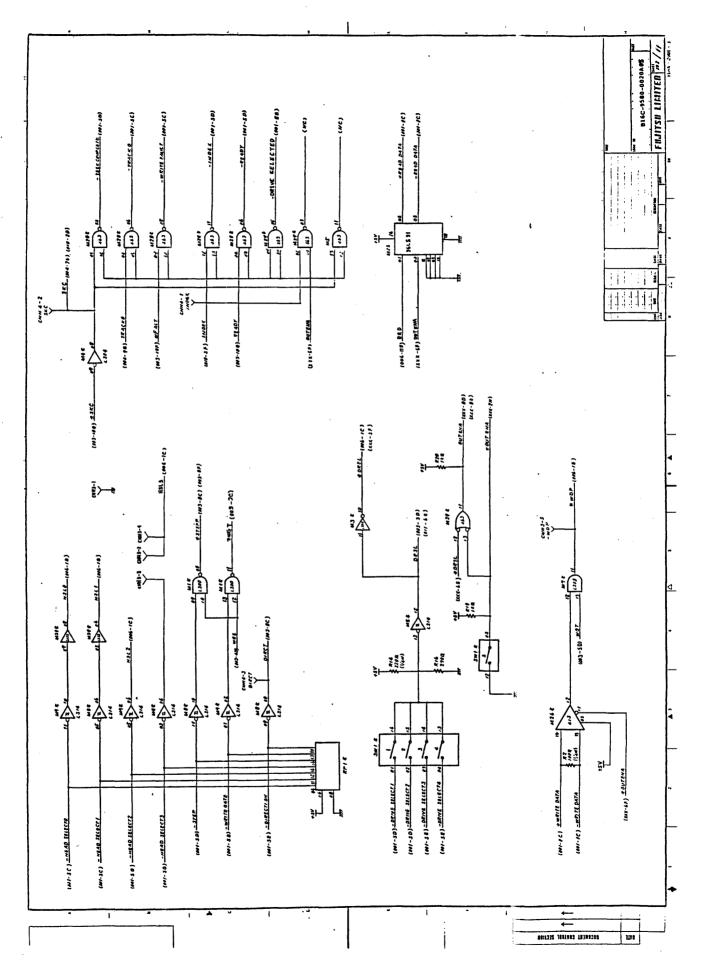


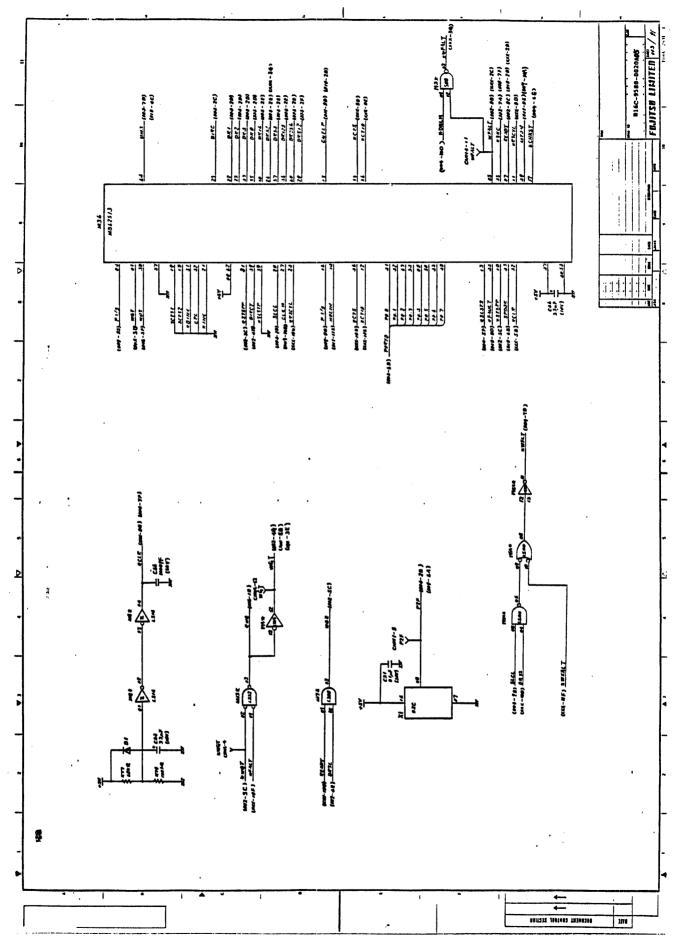
T ≤ 8µs

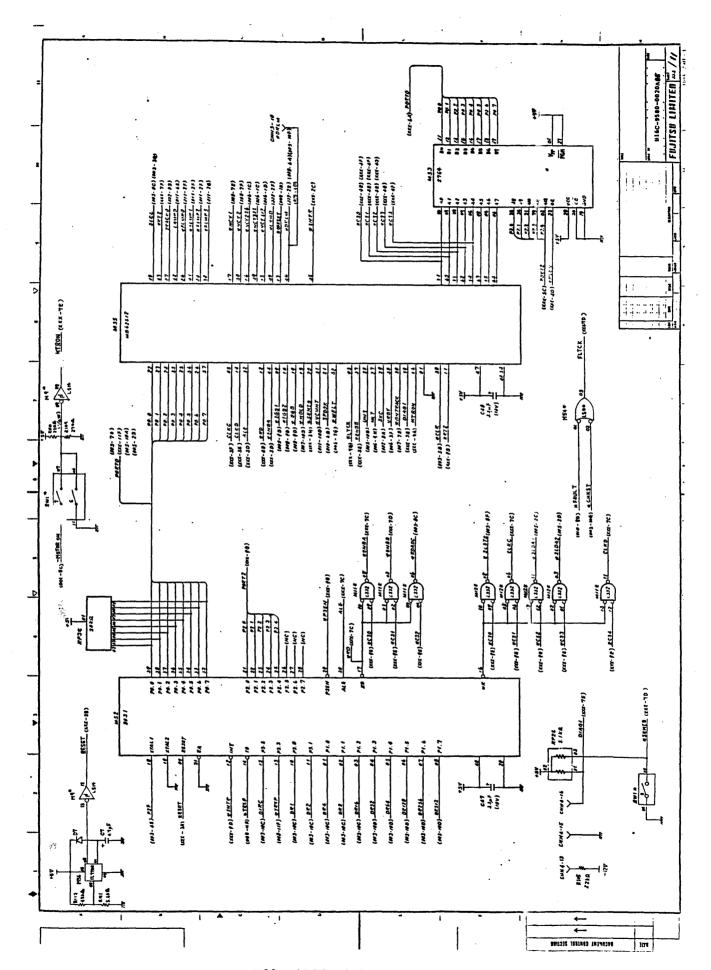
| Item | Part Name | Part Number |
|------|---------------------|----------------------------|
| 1 | DE (HDA) | |
| 2 | Control Y (CZYM) | B16B-9580-0020A |
| 3 | Power Amp S (TVSM) | B16B-9590-0010A |
| 4 | Read Amp C (RKCM) | B16B-9600-0010A |
| 5 | Terminator RM37 | C76L-0970-0001 |
| 6 | Front Panel (BEZEL) | · B030-4800-X141A |
| 7 | Bracket, Right | B030-4800-X013A |
| 8 | Bracket, Left | B030-4800-X014A |
| 9 | Screws | F6-SBD-3 x 6 S (3mm x 6mm) |

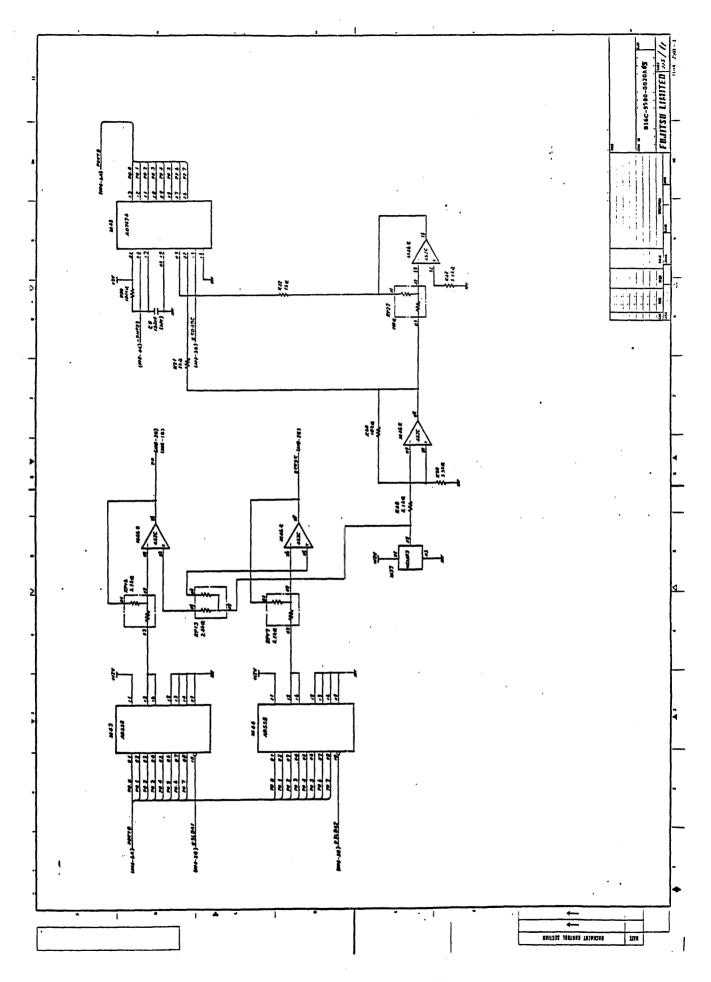


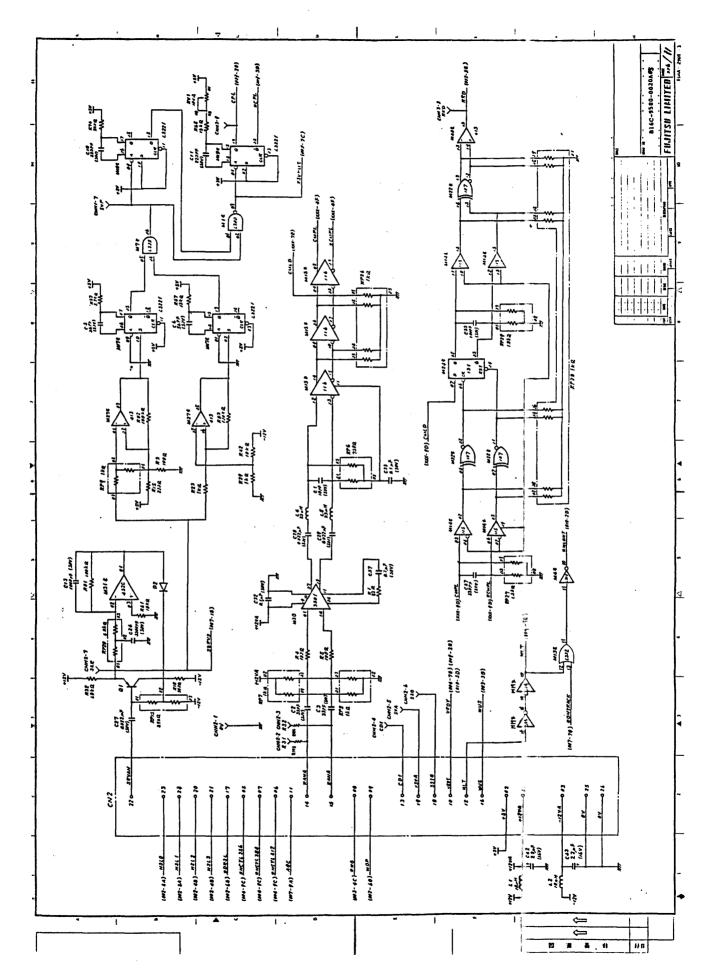


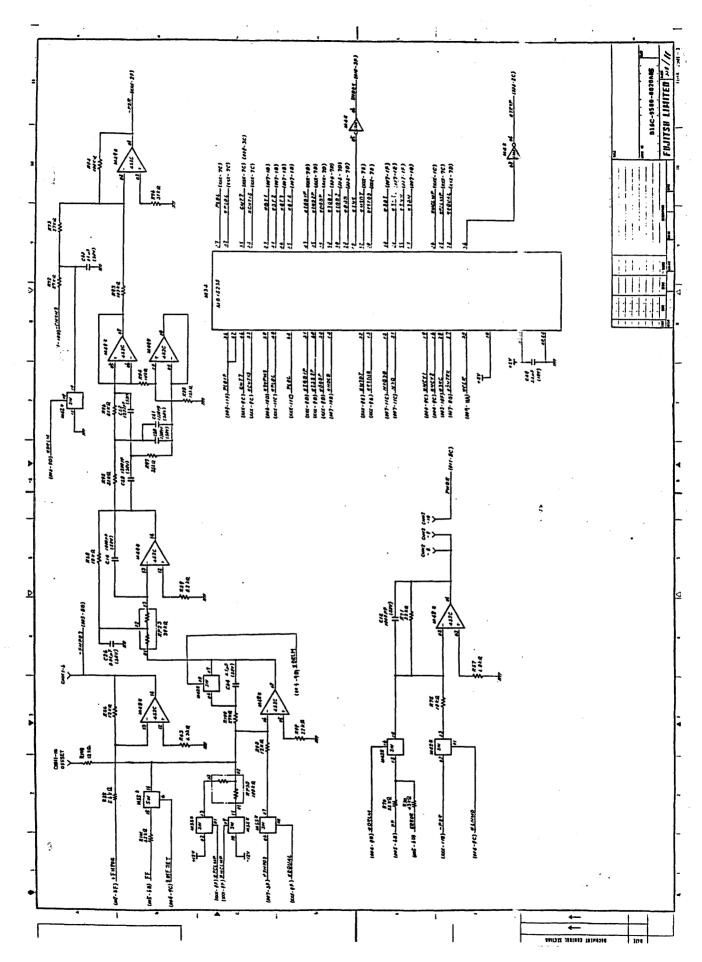


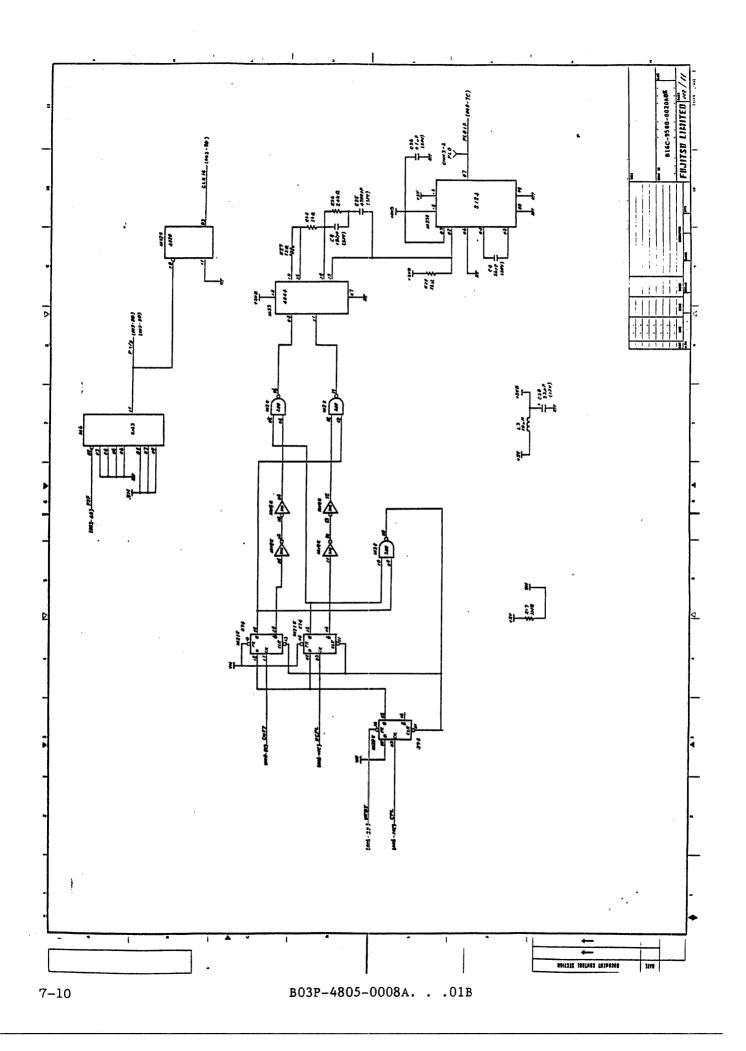


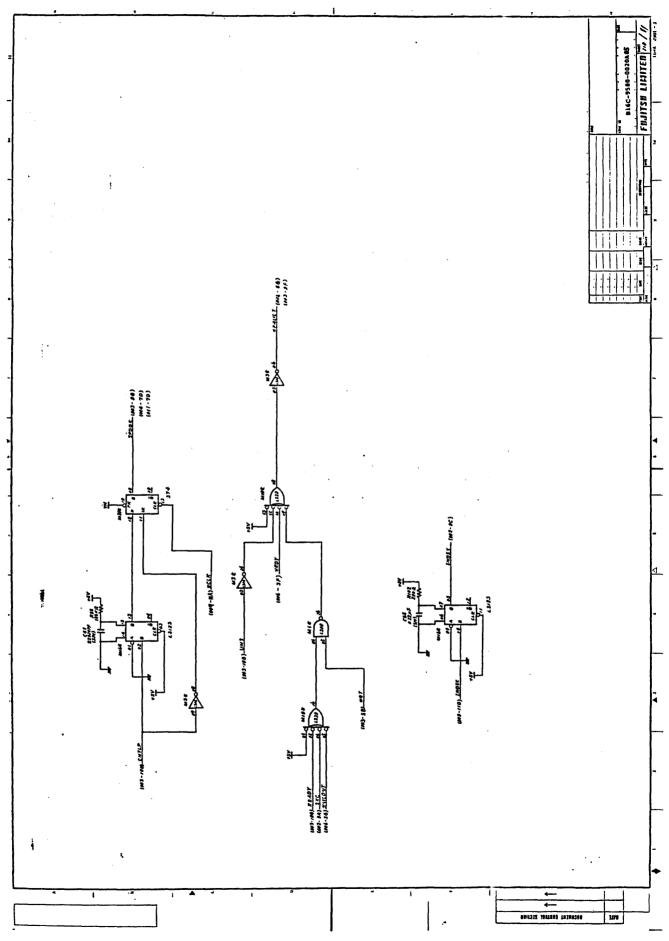


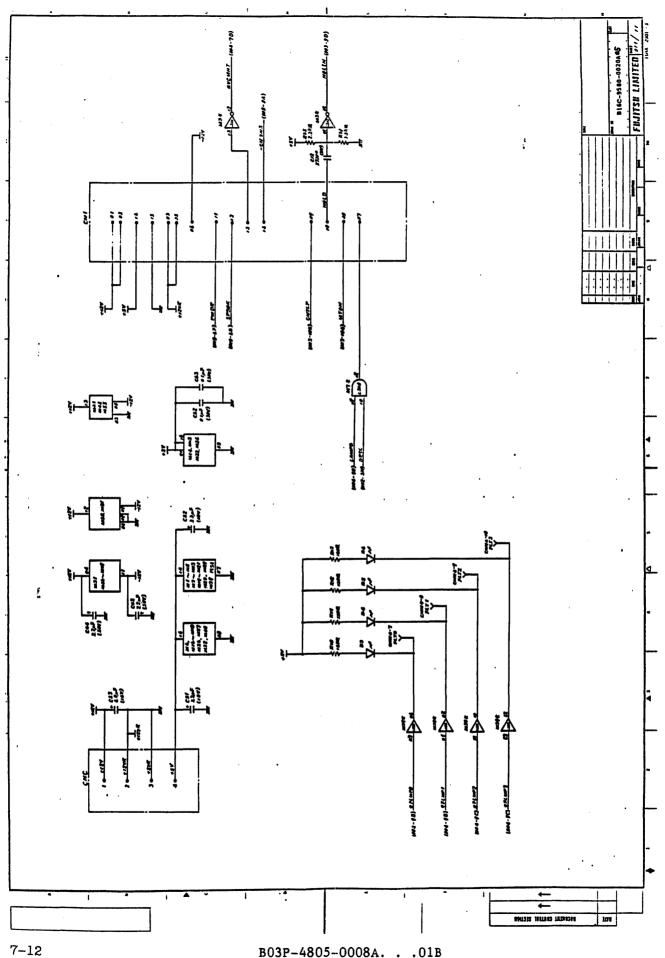


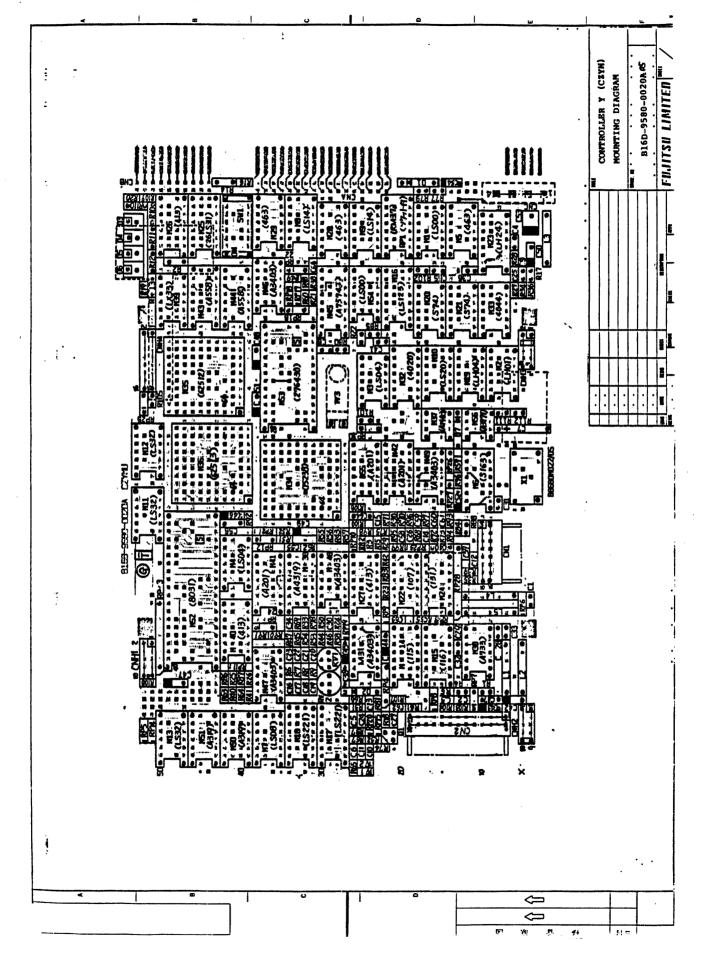


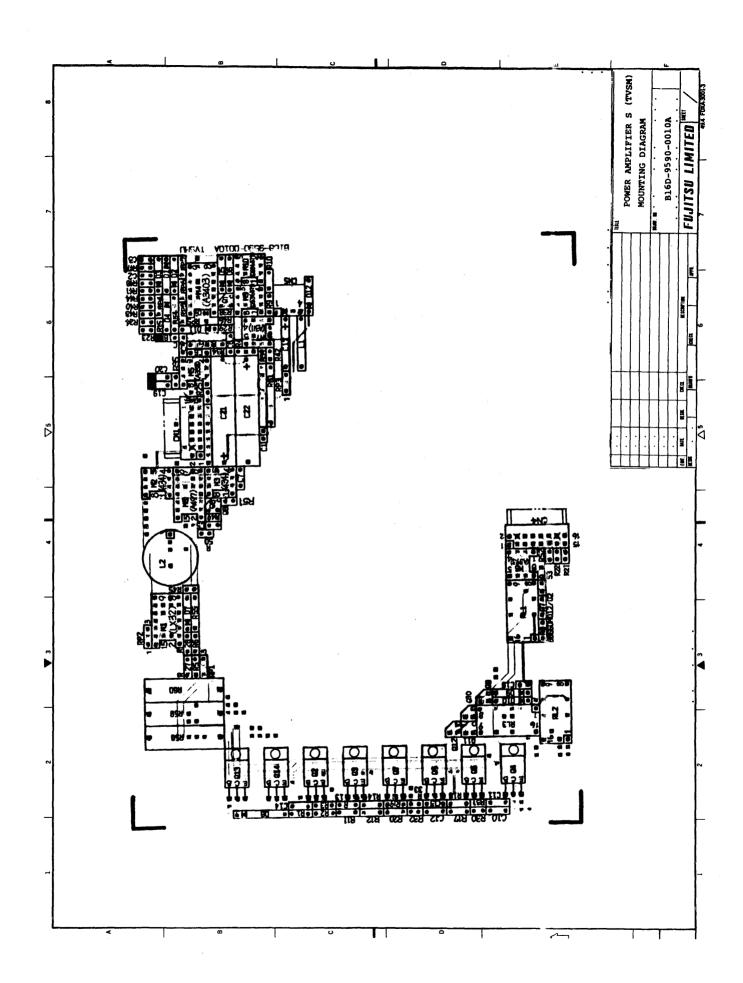


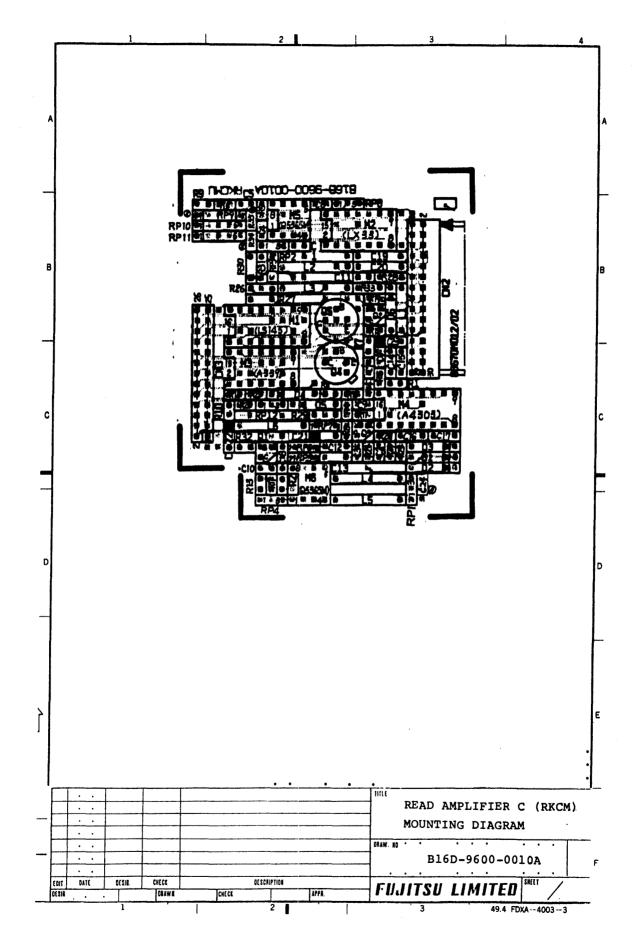












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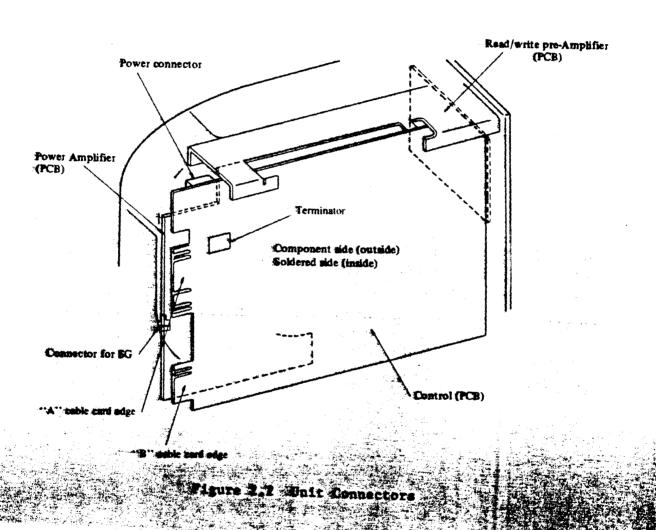
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2.8 Switch setting procedure

The functions and assignment procedures of the switch are described below. The mounting location on the main PCB is illustrated in Figure 2.5.

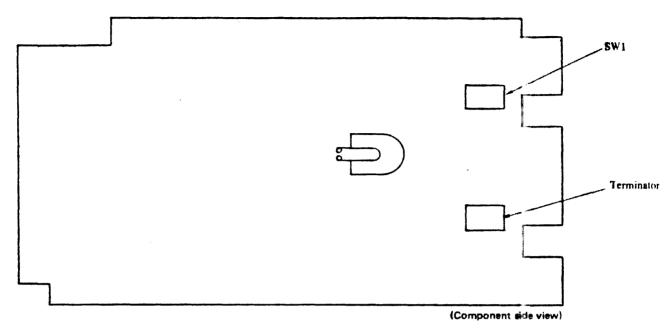


Figure 2.5 Switch Mounting Location

the drive.

- (1) Control of DRIVE SELECTED Signal Key 5 in SW1 "ON" side ... A drive is in a selected state regardless of DRIVE SELECT $1\sim 4$, which means DRIVE SELECTED signal is always true and all Input/Output signals are validated without selecting
 - "OFF" side .. DRIVE SELECTED signal is true and all Input/Output signals are validated only when a drive is selected with DRIVE SELECT 124
- (2) DRIVE SELECTION Key 1 ~ Key 4 in SWl

 Key 1 ~ 4 in SWl are used to select one of up to a maximum of four drives.

 The relevant one of four keys is to be turned ''ON'' while the others should be turned ''OFF.'' The selection procedures are shown in Table 2.2.

Table 2.2 Device Selection

| DRIVE | Key Number in SWl | | | | |
|--------|-------------------|------------|--------------|---|--|
| NUMBER | 1 | 2 | 3 | 4 | |
| 1 | 0 | × | × | × | |
| 2 | × | 0 | x .,. | × | |
| 3 | * | . * | . | * | |
| 4 | × | × | * | 0 | |

O: "OFF"

(3) Keys 6 - B Not used